



**THE DATASHEET OF  
MB95F332KP-G-SH-SNE2**





**MB95F332H/F332K/F333H/F333K/F334H/F334K**

## **F<sup>2</sup>MC-8FX MB95330H Series 8-bit Micro-controllers**

MB95330H is a series of general-purpose, single-chip microcontrollers. In addition to a compact instruction set, the microcontrollers of this series contain a variety of peripheral resources.

### **Features**

#### **F<sup>2</sup>MC-8FX CPU core**

Instruction set optimized for controllers

- Multiplication and division instructions
- 16-bit arithmetic operations
- Bit test branch instructions
- Bit manipulation instructions, etc.

#### **Clock**

- Selectable main clock source
  - Main OSC clock (up to 16.25 MHz, maximum machine clock frequency: 8.125 MHz)
  - External clock (up to 32.5 MHz, maximum machine clock frequency: 16.25 MHz)
  - Main CR clock (1/8/10/12.5 MHz  $\pm$ 2%, maximum machine clock frequency: 12.5 MHz)
- Selectable subclock source
  - Sub-OSC clock (32.768 kHz)
  - External clock (32.768 kHz)
  - Sub-CR clock (Typ: 100 kHz, Min: 50 kHz, Max: 200 kHz)

#### **Timer**

- 8/16-bit composite timer  $\times$  2 channels
- 8/16-bit PPG  $\times$  3 channels
- 16-bit PPG  $\times$  1 channel (can work independently or together with the multi-pulse generator)
- 16-bit reload timer  $\times$  1 channel (can work independently or together with the multi-pulse generator)
- Time-base timer  $\times$  1 channel
- Watch prescaler  $\times$  1 channel

#### **UART/SIO $\times$ 1 channel**

- Full duplex double buffer
- Capable of clock-asynchronous (UART) serial data transfer and clock-synchronous (SIO) serial data transfer

#### **I<sup>2</sup>C $\times$ 1 channel**

- Built-in wake-up function

#### **Multi-pulse generator (MPG) (for DC motor control) $\times$ 1 channel**

- 16-bit reload timer  $\times$  1 channel
- 16-bit PPG timer  $\times$  1 channel
- Waveform sequencer (including a 16-bit timer equipped with a buffer and a compare clear function)

#### **LIN-UART**

- Full duplex double buffer
- Capable of clock-synchronous serial data transfer and clock-asynchronous serial data transfer

#### **External interrupt $\times$ 10 channels**

- Interrupt by edge detection (rising edge, falling edge, and both edges can be selected)
- Can be used to wake up the device from different low power consumption (standby) modes

#### **8/10-bit A/D converter $\times$ 8 channels**

- 8-bit and 10-bit resolution can be chosen.

#### **Low power consumption (standby) modes**

- Stop mode
- Sleep mode
- Watch mode
- Time-base timer mode

#### **I/O port**

- MB95F332H/F333H/F334H (maximum no. of I/O ports: 28)
  - General-purpose I/O ports (N-ch open drain): 3
  - General-purpose I/O ports (CMOS I/O): 25
- MB95F332K/F333K/F334K (maximum no. of I/O ports: 29)
  - General-purpose I/O ports (N-ch open drain): 4
  - General-purpose I/O ports (CMOS I/O): 25

### **On-chip debug**

- 1-wire serial control
- Serial writing supported (asynchronous mode)

### **Hardware/software watchdog timer**

- Built-in hardware watchdog timer

### **Low-voltage detection reset circuit**

- Built-in low-voltage detector

### **Clock supervisor counter**

- Built-in clock supervisor counter function

### **Programmable port input voltage level**

- CMOS input level / hysteresis input level

### **Dual operation Flash memory**

- The erase/write operation and the read operation can be executed in different banks (upper bank/lower bank) simultaneously.

### **Flash memory security function**

- Protects the content of the Flash memory

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## 1. Product Line-up

Part number	MB95F332H	MB95F333H	MB95F334H	MB95F332K	MB95F333K	MB95F334K
<b>Parameter</b>						
Type	Flash memory product					
Clock supervisor counter	It supervises the main clock oscillation.					
Program ROM capacity	8 Kbyte	12 Kbyte	20 Kbyte	8 Kbyte	12 Kbyte	20 Kbyte
RAM capacity	240 bytes	496 bytes	1008 bytes	240 bytes	496 bytes	1008 bytes
Low-voltage detection reset	No			Yes		
Reset input	Dedicated			Selected by software		
CPU functions	Number of basic instructions : 136 Instruction bit length : 8 bits Instruction length : 1 to 3 bytes Data bit length : 1, 8 and 16 bits Minimum instruction execution time : 61.5 ns (with machine clock = 16.25 MHz) Interrupt processing time : 0.6 μs (with machine clock = 16.25 MHz)					
General-purpose I/O	I/O ports (Max): 28 CMOS I/O: 25 N-ch open drain: 3			I/O ports (Max): 29 CMOS I/O: 25 N-ch open drain: 4		
Time-base timer	Interrupt cycle: 0.256 ms to 8.3 s (when external clock = 4 MHz)					
Hardware/software watchdog timer	Reset generation cycle Main oscillation clock at 10 MHz: 105 ms (Min) The sub-CR clock can be used as the source clock of the hardware watchdog timer.					
Wild register	It can be used to replace three bytes of data.					
LIN-UART	A wide range of communication speeds can be selected by a dedicated reload timer. Clock-synchronous serial data transfer and clock-asynchronous serial data transfer is enabled. The LIN function can be used as a LIN master or a LIN slave.					
8/10-bit A/D converter	8 channels 8-bit resolution and 10-bit resolution can be chosen.					
8/16-bit composite timer	2 channels The timer can be configured as an "8-bit timer x 2 channels" or a "16-bit timer x 1 channel". It has built-in timer function, PWC function, PWM function and input capture function. Count clock: it can be selected from internal clocks (seven types) and external clocks. It can output square wave.					
External interrupt	10 channels Interrupt by edge detection (The rising edge, falling edge, or both edges can be selected.) It can be used to wake up the device from different standby modes.					
On-chip debug	1-wire serial control It supports serial writing. (asynchronous mode)					

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Part number	MB95F332H	MB95F333H	MB95F334H	MB95F332K	MB95F333K	MB95F334K
<b>Parameter</b>						
UART/SIO	1 channel Data transfer with UART/SIO is enabled. It has a full duplex double buffer, variable data length (5/6/7/8 bits), a built-in baud rate generator and an error detection function. It uses the NRZ type transfer format. LSB-first data transfer and MSB-first data transfer are available to use. Clock-asynchronous (UART) serial data transfer and clock-synchronous (SIO) serial data transfer is enabled.					
I <sup>2</sup> C	1 channel Master/slave transmission and receiving It has a bus error function, an arbitration function, a transmission direction detection function and a wake-up function. It also has functions of generating and detecting repeated START conditions.					
8/16-bit PPG	3 channels Each channel of PPG can be used as two 8-bit PPG channels or a single 16-bit PPG channel. The counter operating clock can be selected from eight clock sources.					
16-bit PPG	PWM mode and one-shot mode are available to use. The counter operating clock can be selected from eight clock sources. It supports external trigger start. It can work independently or together with the multi-pulse generator.					
16-bit reload timer	Two clock modes and two counter operating modes are available to use. It can output square waveform. Count clock: it can be selected from internal clocks (seven types) and external clocks. Two counter operating modes: reload mode and one-shot mode It can work independently or together with the multi-pulse generator.					
Multi-pulse generator (for DC motor control)	16-bit PPG timer: 1 channel 16-bit reload timer operations: toggle output, one-shot output Event counter: 1 channel Waveform sequencer (including a 16-bit timer equipped with a buffer and a compare clear function)					
Watch prescaler	Eight different time intervals can be selected.					
Flash memory	It supports automatic programming, Embedded Algorithm, and write/erase/erase-suspend/erase-resume commands. It has a flag indicating the completion of the operation of Embedded Algorithm. Number of write/erase cycles: 100000 Data retention time: 20 years Flash security feature for protecting the content of the Flash memory					
Standby mode	Sleep mode, stop mode, watch mode, time-base timer mode					
Package	FPT-32P-M30 DIP-32P-M06 LCC-32P-M19					

## 2. Packages and Corresponding Products

Part number / Package	MB95F332H	MB95F332K	MB95F333H	MB95F333K	MB95F334H	MB95F334K
FPT-32P-M30	O	O	O	O	O	O
DIP-32P-M06	O	O	O	O	O	O
LCC-32P-M19	O	O	O	O	O	O

O: Available

## 3. Differences Among Products and Notes On Product Selection

■ • Current consumption

When using the on-chip debug function, take account of the current consumption of flash erase/write.

For details of current consumption, see “Electrical Characteristics”.

■ • Package

For details of information on each package, see “Packages and Corresponding Products” and “Package Dimension”.

■ • Operating voltage

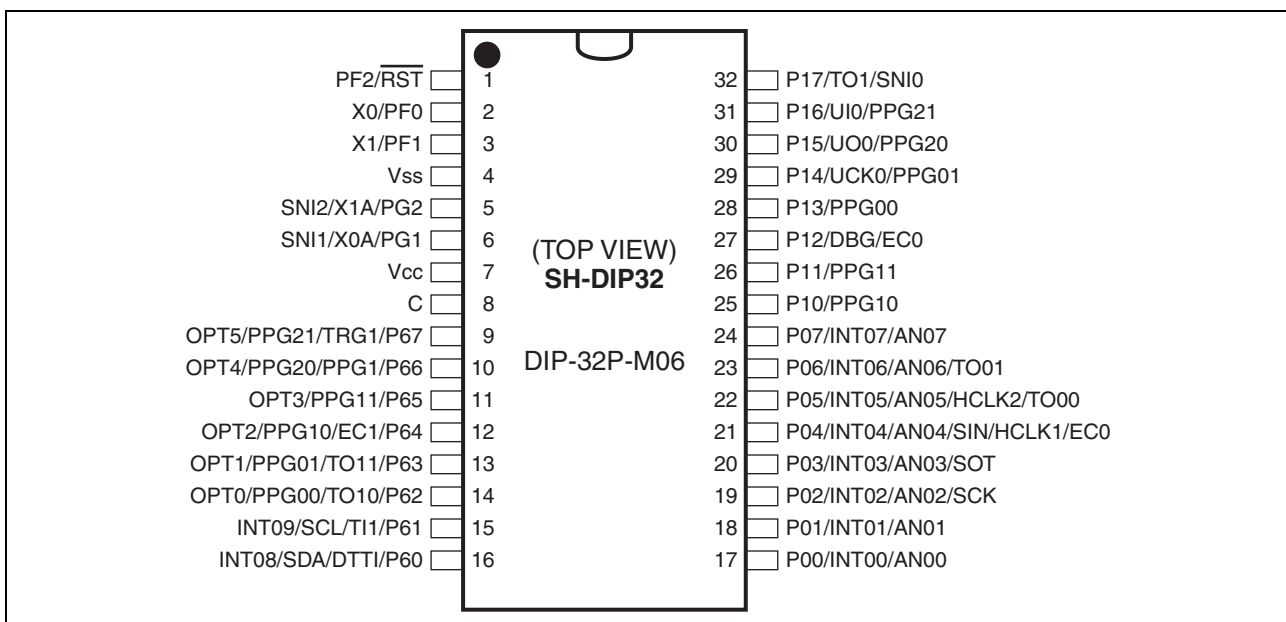
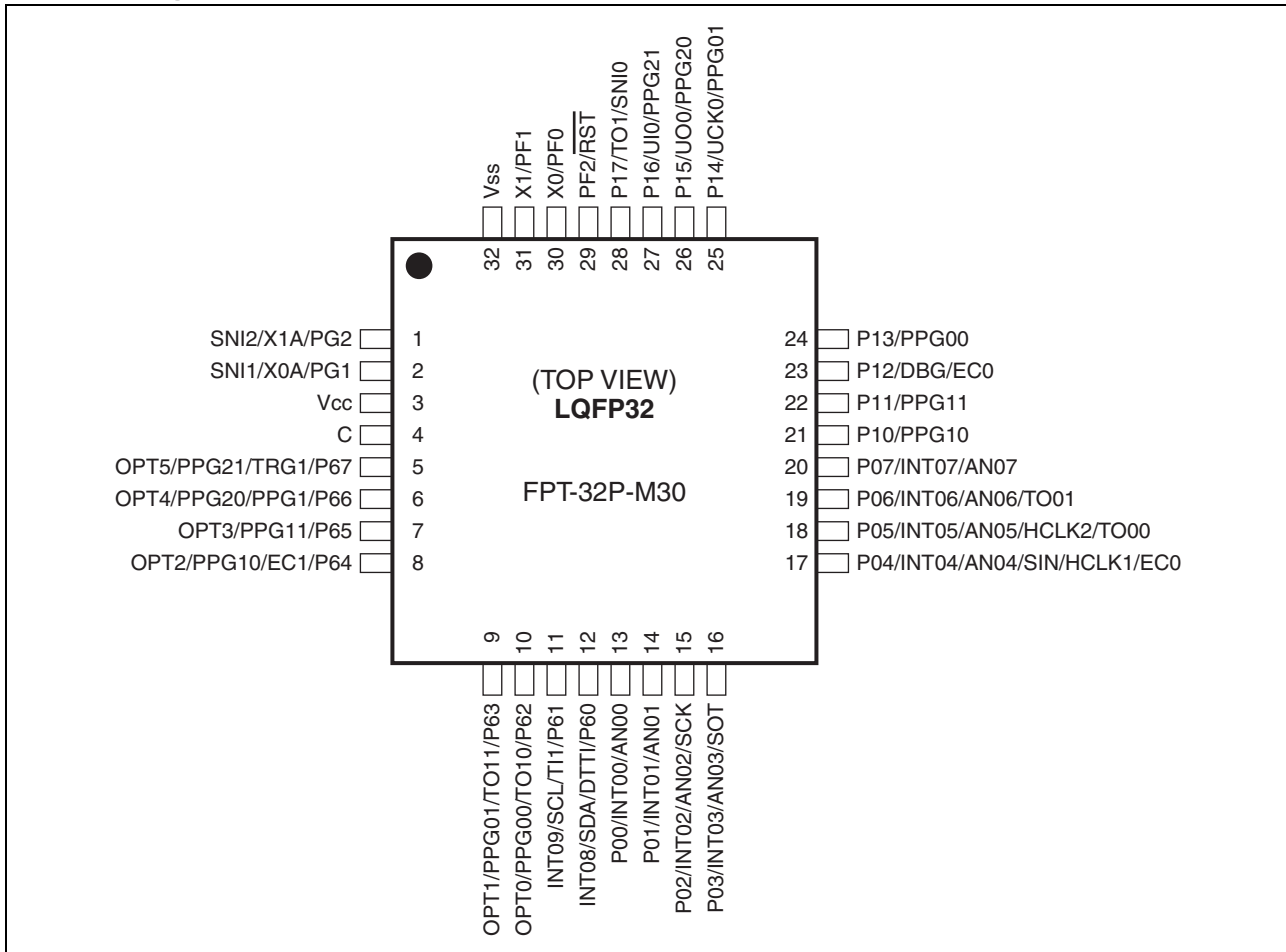
The operating voltage varies, depending on whether the on-chip debug function is used or not.

For details of the operating voltage, see “Electrical Characteristics”.

■ • On-chip debug function

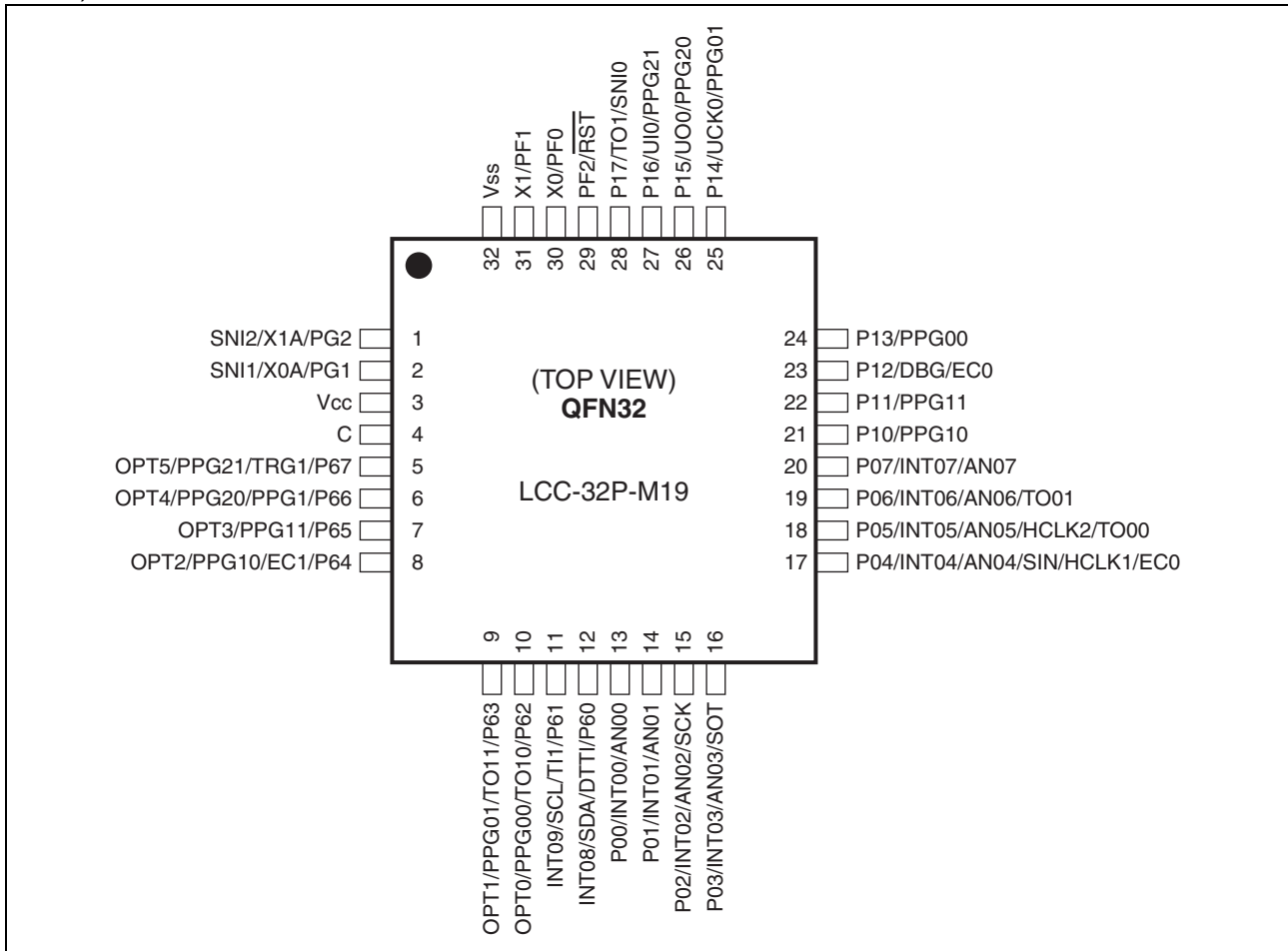
The on-chip debug function requires that  $V_{CC}$ ,  $V_{SS}$  and one serial wire be connected to an evaluation tool.

### 4. Pin Assignment



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## 5. Pin Description

Pin no.		Pin name	I/O circuit type*4	Function
LQFP32*1 & QFN32*2	SH-DIP32*3			
1	5	PG2	C	General-purpose I/O port
		X1A		Subclock I/O oscillation pin
		SNI2		Trigger input pin for the position detection function of the MPG waveform sequencer
2	6	PG1	C	General-purpose I/O port
		X0A		Subclock input oscillation pin
		SNI1		Trigger input pin for the position detection function of the MPG waveform sequencer
3	7	V <sub>CC</sub>	—	Power supply pin
4	8	C	—	Capacitor connection pin
5	9	P67	D	General-purpose I/O port High-current pin
		PPG21		8/16-bit PPG ch. 2 output pin
		TRG1		16-bit PPG ch. 1 trigger input pin
		OPT5		MPG waveform sequencer output pin
6	10	P66	D	General-purpose I/O port High-current pin
		PPG20		8/16-bit PPG ch. 2 output pin
		PPG1		16-bit PPG ch. 1 output pin
		OPT4		MPG waveform sequencer output pin
7	11	P65	D	General-purpose I/O port High-current pin
		PPG11		8/16-bit PPG ch. 1 output pin
		OPT3		MPG waveform sequencer output pin
8	12	P64	D	General-purpose I/O port High-current pin
		EC1		8/16-bit composite timer ch. 1 clock input pin
		PPG10		8/16-bit PPG ch. 1 output pin
		OPT2		MPG waveform sequencer output pin
9	13	P63	D	General-purpose I/O port High-current pin
		TO11		8/16-bit composite timer ch. 1 output pin
		PPG01		8/16-bit PPG ch. 0 output pin
		OPT1		MPG waveform sequencer output pin

(Continued)

Pin no.		Pin name	I/O circuit type*4	Function
LQFP32*1 & QFN32*2	SH-DIP32*3			
10	14	P62	D	General-purpose I/O port High-current pin
		TO10		8/16-bit composite timer ch. 1 output pin
		PPG00		8/16-bit PPG ch. 0 output pin
		OPT0		MPG waveform sequencer output pin
11	15	P61	I	General-purpose I/O port
		INT09		External interrupt input pin
		SCL		I <sup>2</sup> C clock I/O pin
		TI1		16-bit reload timer ch. 1 input pin
12	16	P60	I	General-purpose I/O port
		INT08		External interrupt input pin
		SDA		I <sup>2</sup> C data I/O pin
		DTTI		MPG waveform sequencer input pin
13	17	P00	E	General-purpose I/O port
		INT00		External interrupt input pin
		AN00		A/D converter analog input pin
14	18	P01	E	General-purpose I/O port
		INT01		External interrupt input pin
		AN01		A/D converter analog input pin
15	19	P02	E	General-purpose I/O port
		INT02		External interrupt input pin
		AN02		A/D converter analog input pin
		SCK		LIN-UART clock I/O pin
16	20	P03	E	General-purpose I/O port
		INT03		External interrupt input pin
		AN03		A/D converter analog input pin
		SOT		LIN-UART data output pin
17	21	P04	F	General-purpose I/O port
		INT04		External interrupt input pin
		AN04		A/D converter analog input pin
		SIN		LIN-UART data input pin
		HCLK1		External clock input pin
		EC0		8/16-bit composite timer ch. 0 clock input pin

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Pin no.		Pin name	I/O circuit type <sup>*4</sup>	Function
LQFP32 <sup>*1</sup> & QFN32 <sup>*2</sup>	SH-DIP32 <sup>*3</sup>			
18	22	P05	E	General-purpose I/O port
		INT05		External interrupt input pin
		AN05		A/D converter analog input pin
		HCLK2		External clock input pin
		TO00		8/16-bit composite timer ch. 0 output pin
19	23	P06	E	General-purpose I/O port
		INT06		External interrupt input pin
		AN06		A/D converter analog input pin
		TO01		8/16-bit composite timer ch. 0 output pin
20	24	P07	E	General-purpose I/O port
		INT07		External interrupt input pin
		AN07		A/D converter analog input pin
21	25	P10	G	General-purpose I/O port
		PPG10		8/16-bit PPG ch. 1 output pin
22	26	P11	G	General-purpose I/O port
		PPG11		8/16-bit PPG ch. 1 output pin
23	27	P12	H	General-purpose I/O port
		DBG		DBG input pin
		EC0		8/16-bit composite timer ch. 0 clock input pin
24	28	P13	G	General-purpose I/O port
		PPG00		8/16-bit PPG ch. 0 output pin
25	29	P14	G	General-purpose I/O port
		UCK0		UART/SIO ch. 0 clock I/O pin
		PPG01		8/16-bit PPG ch. 0 output pin
26	30	P15	G	General-purpose I/O port
		U00		UART/SIO ch. 0 data output pin
		PPG20		8/16-bit PPG ch. 2 output pin
27	31	P16	J	General-purpose I/O port
		UI0		UART/SIO ch. 0 data input pin
		PPG21		8/16-bit PPG ch. 2 output pin
28	32	P17	G	General-purpose I/O port
		TO1		16-bit reload timer ch. 1 output pin
		SNI0		Trigger input pin for the position detection function of the MPG waveform sequencer
29	1	PF2	A	General-purpose I/O port
		$\overline{\text{RST}}$		Reset pin Dedicated reset pin in MB95F332H/F333H/F334H

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Pin no.		Pin name	I/O circuit type <sup>*4</sup>	Function
LQFP32 <sup>*1</sup> & QFN32 <sup>*2</sup>	SH-DIP32 <sup>*3</sup>			
30	2	PF0	B	General-purpose I/O port
		X0		Main clock input oscillation pin
31	3	PF1	B	General-purpose I/O port
		X1		Main clock I/O oscillation pin
32	4	V <sub>SS</sub>	—	Power supply pin (GND)

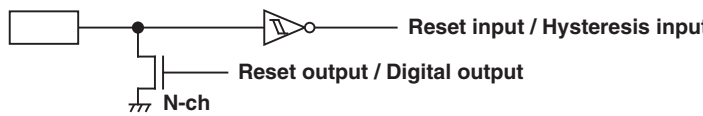
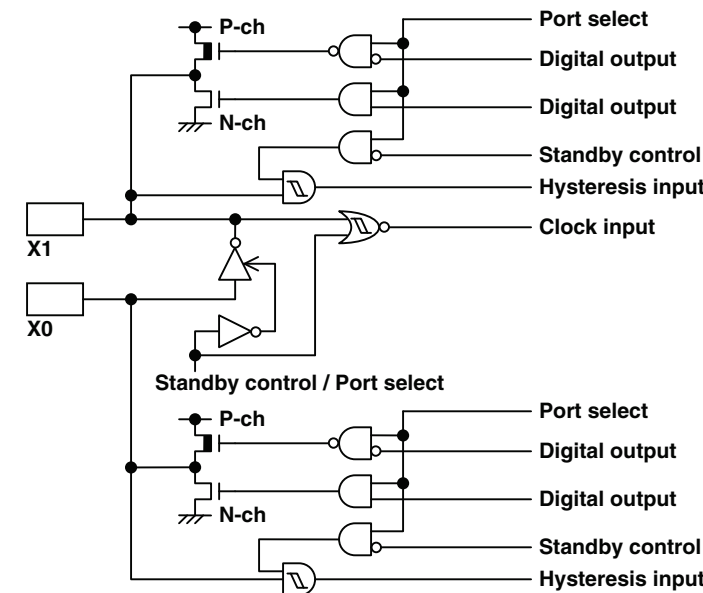
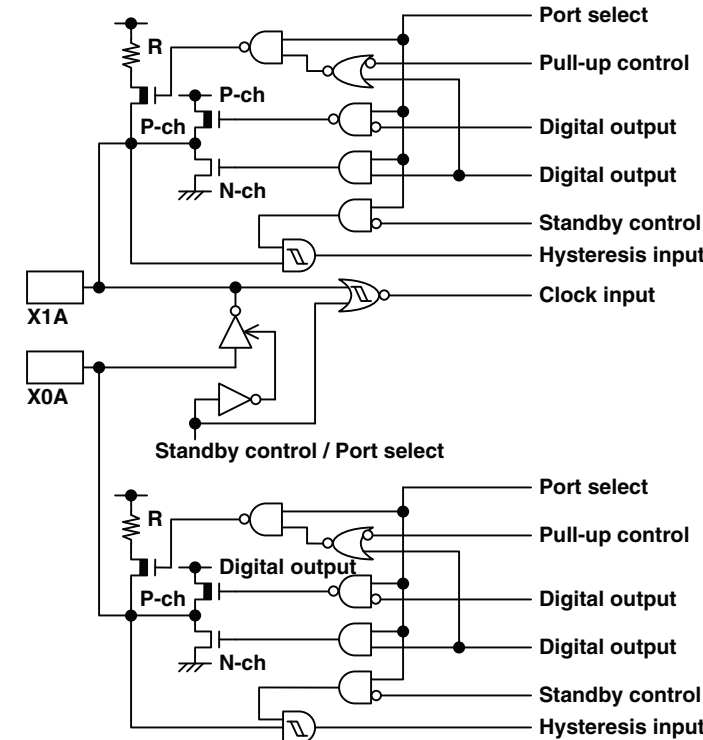
\*1: Package code: FPT-32P-M30

\*2: Package code: LCC-32P-M19

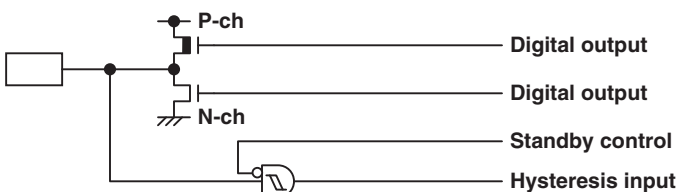
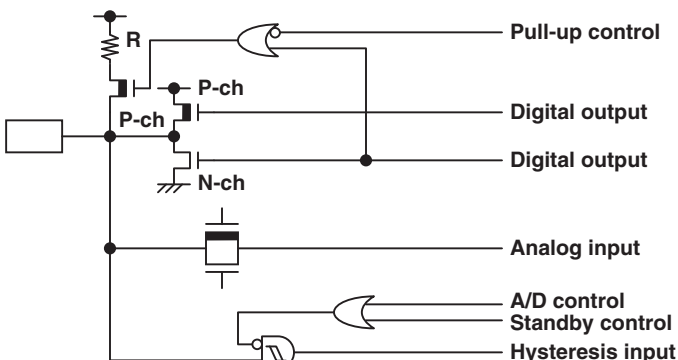
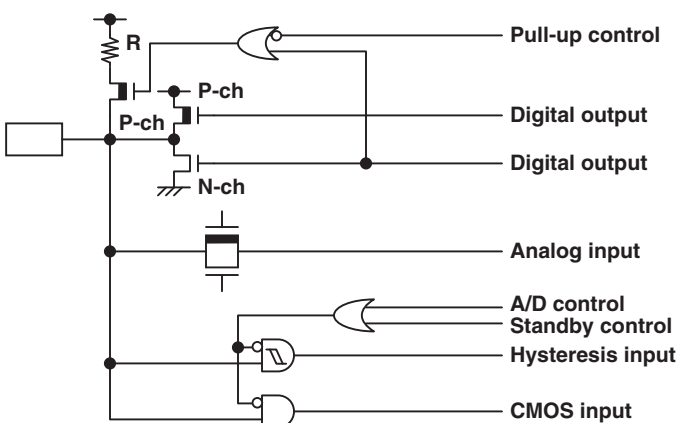
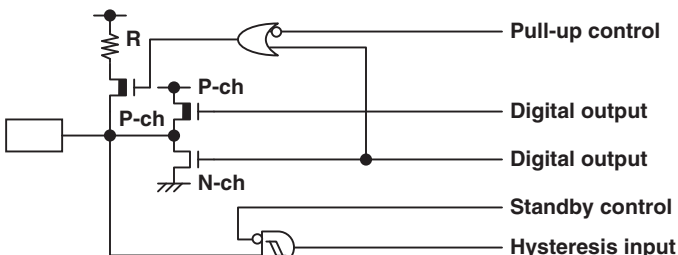
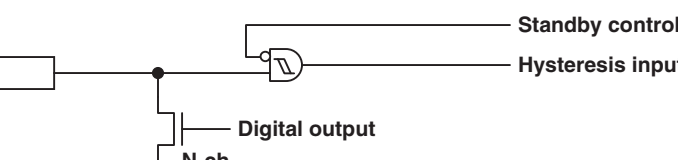
\*3: Package code: DIP-32P-M06

\*4: For the I/O circuit types, see "I/O Circuit Type".

## 6. I/O Circuit Type

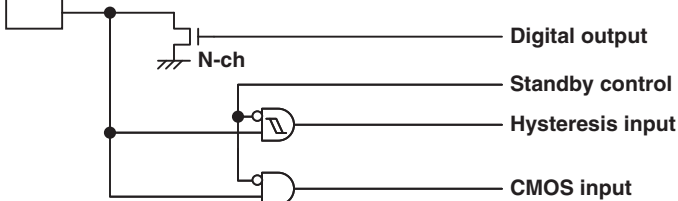
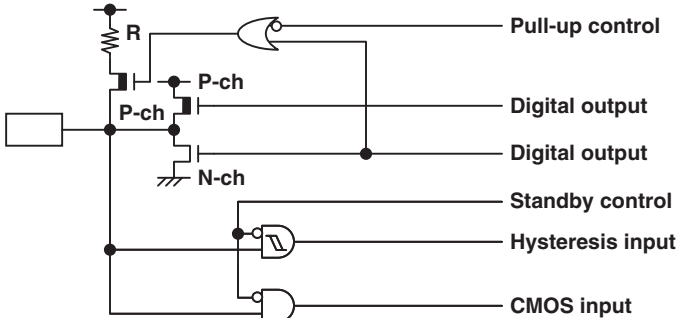
Type	Circuit	Remarks
A		<ul style="list-style-type: none"> <li>■ N-ch open drain output</li> <li>■ Hysteresis input</li> <li>■ Reset output</li> </ul>
B		<ul style="list-style-type: none"> <li>■ Oscillation circuit</li> <li>■ High-speed side Feedback resistance: approx. 1 MΩ</li> <li>■ CMOS output</li> <li>■ Hysteresis input</li> </ul>
C		<ul style="list-style-type: none"> <li>■ Oscillation circuit</li> <li>■ Low-speed side Feedback resistance: approx. 10 MΩ</li> <li>■ CMOS output</li> <li>■ Hysteresis input</li> <li>■ Pull-up control available</li> </ul>

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Type	Circuit	Remarks
D		<ul style="list-style-type: none"> <li>■ CMOS output</li> <li>■ Hysteresis input</li> </ul>
E		<ul style="list-style-type: none"> <li>■ CMOS output</li> <li>■ Hysteresis input</li> <li>■ Pull-up control available</li> </ul>
F		<ul style="list-style-type: none"> <li>■ CMOS output</li> <li>■ Hysteresis input</li> <li>■ CMOS input</li> <li>■ Pull-up control available</li> </ul>
G		<ul style="list-style-type: none"> <li>■ Hysteresis input</li> <li>■ CMOS output</li> <li>■ Pull-up control available</li> </ul>
H		<ul style="list-style-type: none"> <li>■ N-ch open drain output</li> <li>■ Hysteresis input</li> </ul>

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Type	Circuit	Remarks
I		<ul style="list-style-type: none"> <li>■ N-ch open drain output</li> <li>■ Hysteresis input</li> <li>■ CMOS input</li> </ul>
J		<ul style="list-style-type: none"> <li>■ CMOS output</li> <li>■ Hysteresis input</li> <li>■ CMOS input</li> <li>■ Pull-up control available</li> </ul>

## 7. Notes On Device Handling

### ■ Preventing latch-ups

When using the device, ensure that the voltage applied does not exceed the maximum voltage rating.

In a CMOS IC, if a voltage higher than  $V_{CC}$  or a voltage lower than  $V_{SS}$  is applied to an input/output pin that is neither a medium-withstand voltage pin nor a high-withstand voltage pin, or if a voltage out of the rating range of power supply voltage mentioned in "13.1 Absolute Maximum Ratings" of "■ Electrical Characteristics" is applied to the  $V_{CC}$  pin or the  $V_{SS}$  pin, a latch-up may occur.

When a latch-up occurs, power supply current increases significantly, which may cause a component to be thermally destroyed.

### ■ Stabilizing supply voltage

Supply voltage must be stabilized.

A malfunction may occur when power supply voltage fluctuates rapidly even though the fluctuation is within the guaranteed operating range of the  $V_{CC}$  power supply voltage.

As a rule of voltage stabilization, suppress voltage fluctuation so that the fluctuation in  $V_{CC}$  ripple (p-p value) at the commercial frequency (50 Hz/60 Hz) does not exceed 10% of the standard  $V_{CC}$  value, and the transient fluctuation rate does not exceed 0.1 V/ms at a momentary fluctuation such as switching the power supply.

### ■ Notes on using the external clock

When an external clock is used, oscillation stabilization wait time is required for power-on reset, wake-up from subclock mode or stop mode.

## 8. Pin Connection

### ■ Treatment of unused pins

If an unused input pin is left unconnected, a component may be permanently damaged due to malfunctions or latch-ups. Always pull up or pull down an unused input pin through a resistor of at least 2 k $\Omega$ . Set an unused input/output pin to the output state and leave it unconnected, or set it to the input state and treat it the same as an unused input pin. If there is an unused output pin, leave it unconnected.

■ Power supply pins

To reduce unnecessary electro-magnetic emission, prevent malfunctions of strobe signals due to an increase in the ground level, and conform to the total output current standard, always connect the  $V_{CC}$  pin and the  $V_{SS}$  pin to the power supply and ground outside the device. In addition, connect the current supply source to the  $V_{CC}$  pin and the  $V_{SS}$  pin with low impedance.

It is also advisable to connect a ceramic capacitor of approximately 0.1  $\mu\text{F}$  as a bypass capacitor between the  $V_{CC}$  pin and the  $V_{SS}$  pin at a location close to this device.

■ DBG pin

Connect the DBG pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the debug mode due to noise, minimize the distance between the DBG pin and the  $V_{CC}$  or  $V_{SS}$  pin when designing the layout of the printed circuit board.

The DBG pin should not stay at “L” level after power-on until the reset output is released.

■  $\overline{\text{RST}}$  pin

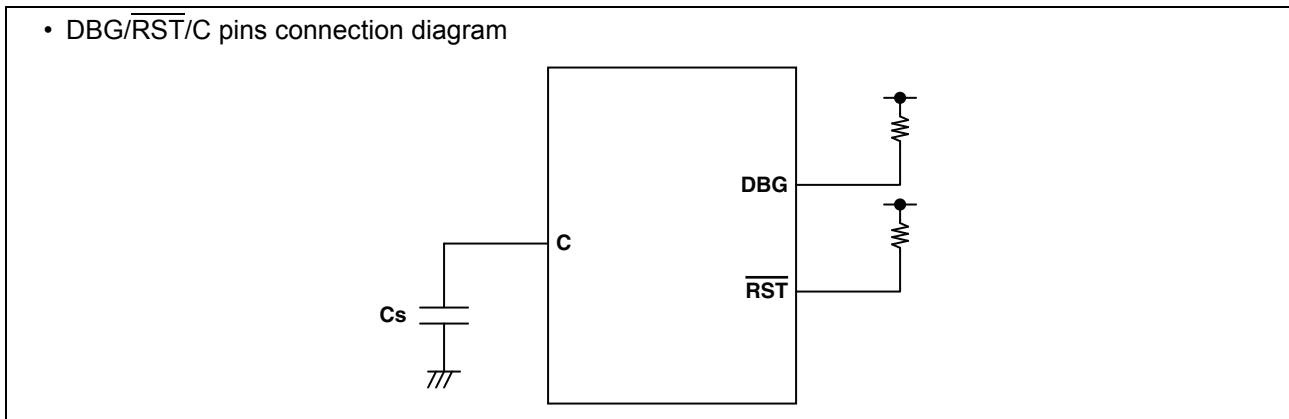
Connect the  $\overline{\text{RST}}$  pin directly to an external pull-up resistor.

To prevent the device from unintentionally entering the reset mode due to noise, minimize the distance between the  $\overline{\text{RST}}$  pin and the  $V_{CC}$  or  $V_{SS}$  pin when designing the layout of the printed circuit board.

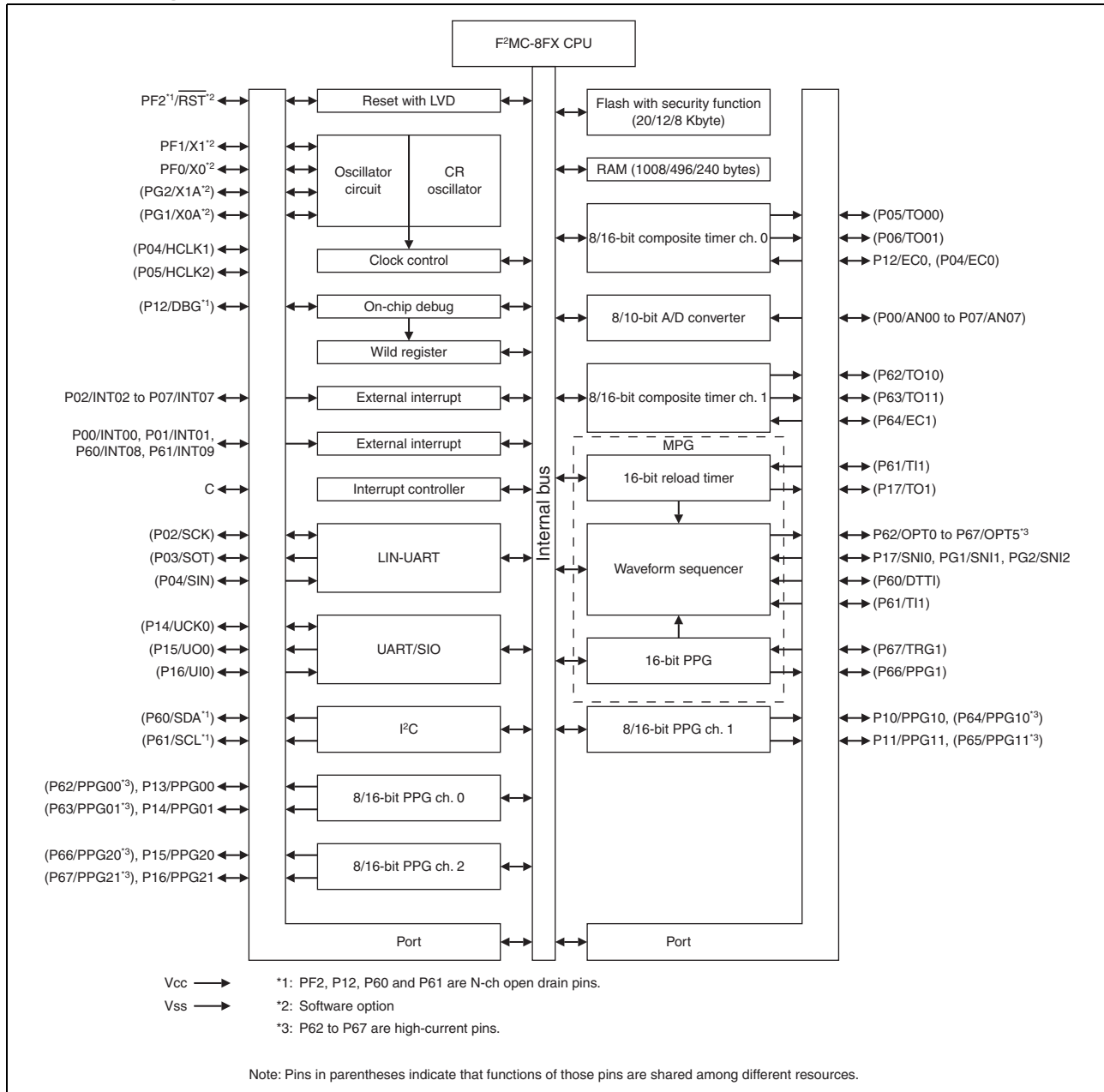
The  $\overline{\text{RST}}$ /PF2 pin functions as the reset input/output pin after power-on. In addition, the reset output of the  $\overline{\text{RST}}$ /PF2 pin can be enabled by the RSTOE bit of the SYSC register, and the reset input function and the general purpose I/O function can be selected by the RSTEN bit of the SYSC register.

■ C pin

Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the  $V_{CC}$  pin must have a capacitance larger than  $C_S$ . For the connection to a smoothing capacitor  $C_S$ , see the diagram below. To prevent the device from unintentionally entering a mode to which the device is not set to transit due to noise, minimize the distance between the C pin and  $C_S$  and the distance between  $C_S$  and the  $V_{SS}$  pin when designing the layout of a printed circuit board.



## 9. Block Diagram



## 10. CPU Core

### ■ Memory Space

The memory space of the MB95330H Series is 64 Kbyte in size, and consists of an I/O area, a data area, and a program area. The memory space includes areas intended for specific purposes such as general-purpose registers and a vector table. The memory maps of the MB95330H Series are shown below.

## ■ Memory Maps

MB95F332H/F332K		MB95F333H/F333K		MB95F334H/F334K	
0000 <sub>H</sub>	I/O	0000 <sub>H</sub>	I/O	0000 <sub>H</sub>	I/O
0080 <sub>H</sub>	Access prohibited	0080 <sub>H</sub>	Access prohibited	0080 <sub>H</sub>	Access prohibited
0090 <sub>H</sub>	RAM 240 bytes	0090 <sub>H</sub>	RAM 496 bytes	0090 <sub>H</sub>	RAM 1008 bytes
0100 <sub>H</sub>	Register	0100 <sub>H</sub>	Register	0100 <sub>H</sub>	Register
0180 <sub>H</sub>	Access prohibited	0200 <sub>H</sub>	Access prohibited	0200 <sub>H</sub>	Access prohibited
0F80 <sub>H</sub>	Extended I/O	0F80 <sub>H</sub>	Extended I/O	0F80 <sub>H</sub>	Extended I/O
1000 <sub>H</sub>	Access prohibited	1000 <sub>H</sub>	Access prohibited	1000 <sub>H</sub>	Access prohibited
B000 <sub>H</sub>	Flash 4 Kbyte	B000 <sub>H</sub>	Flash 4 Kbyte	B000 <sub>H</sub>	Flash 20 Kbyte
C000 <sub>H</sub>	Access prohibited	C000 <sub>H</sub>	Access prohibited	FFFF <sub>H</sub>	Flash 20 Kbyte
F000 <sub>H</sub>	Flash 4 Kbyte	E000 <sub>H</sub>	Flash 8 Kbyte		
FFFF <sub>H</sub>		FFFF <sub>H</sub>			

## 11. I/O Map

Address	Register abbreviation	Register name	R/W	Initial value
0000 <sub>H</sub>	PDR0	Port 0 data register	R/W	00000000 <sub>B</sub>
0001 <sub>H</sub>	DDR0	Port 0 direction register	R/W	00000000 <sub>B</sub>
0002 <sub>H</sub>	PDR1	Port 1 data register	R/W	00000000 <sub>B</sub>
0003 <sub>H</sub>	DDR1	Port 1 direction register	R/W	00000000 <sub>B</sub>
0004 <sub>H</sub>	—	(Disabled)	—	—
0005 <sub>H</sub>	WATR	Oscillation stabilization wait time setting register	R/W	11111111 <sub>B</sub>
0006 <sub>H</sub>	—	(Disabled)	—	—
0007 <sub>H</sub>	SYCC	System clock control register	R/W	0000X011 <sub>B</sub>
0008 <sub>H</sub>	STBC	Standby control register	R/W	00000XXX <sub>B</sub>
0009 <sub>H</sub>	RSRR	Reset source register	R/W	XXXXXXXX <sub>B</sub>
000A <sub>H</sub>	TBTC	Time-base timer control register	R/W	00000000 <sub>B</sub>
000B <sub>H</sub>	WPCR	Watch prescaler control register	R/W	00000000 <sub>B</sub>
000C <sub>H</sub>	WDTC	Watchdog timer control register	R/W	00XX0000 <sub>B</sub>
000D <sub>H</sub>	SYCC2	System clock control register 2	R/W	XX100011 <sub>B</sub>
000E <sub>H</sub> to 0015 <sub>H</sub>	—	(Disabled)	—	—
0016 <sub>H</sub>	PDR6	Port 6 data register	R/W	00000000 <sub>B</sub>
0017 <sub>H</sub>	DDR6	Port 6 direction register	R/W	00000000 <sub>B</sub>
0018 <sub>H</sub> to 0027 <sub>H</sub>	—	(Disabled)	—	—
0028 <sub>H</sub>	PDRF	Port F data register	R/W	00000000 <sub>B</sub>
0029 <sub>H</sub>	DDRF	Port F direction register	R/W	00000000 <sub>B</sub>
002A <sub>H</sub>	PDRG	Port G data register	R/W	00000000 <sub>B</sub>
002B <sub>H</sub>	DDRG	Port G direction register	R/W	00000000 <sub>B</sub>
002C <sub>H</sub>	PUL0	Port 0 pull-up register	R/W	00000000 <sub>B</sub>
002D <sub>H</sub>	PUL1	Port 1 pull-up register	R/W	00000000 <sub>B</sub>
002E <sub>H</sub> to 0034 <sub>H</sub>	—	(Disabled)	—	—
0035 <sub>H</sub>	PULG	Port G pull-up register	R/W	00000000 <sub>B</sub>
0036 <sub>H</sub>	T01CR1	8/16-bit composite timer 01 status control register 1 ch. 0	R/W	00000000 <sub>B</sub>
0037 <sub>H</sub>	T00CR1	8/16-bit composite timer 00 status control register 1 ch. 0	R/W	00000000 <sub>B</sub>
0038 <sub>H</sub>	T11CR1	8/16-bit composite timer 11 status control register 1 ch. 1	R/W	00000000 <sub>B</sub>
0039 <sub>H</sub>	T10CR1	8/16-bit composite timer 10 status control register 1 ch. 1	R/W	00000000 <sub>B</sub>
003A <sub>H</sub>	PC01	8/16-bit PPG timer 01 control register ch. 0	R/W	00000000 <sub>B</sub>
003B <sub>H</sub>	PC00	8/16-bit PPG timer 00 control register ch. 0	R/W	00000000 <sub>B</sub>
003C <sub>H</sub>	PC11	8/16-bit PPG timer 11 control register ch. 1	R/W	00000000 <sub>B</sub>
003D <sub>H</sub>	PC10	8/16-bit PPG timer 10 control register ch. 1	R/W	00000000 <sub>B</sub>
003E <sub>H</sub>	PC21	8/16-bit PPG timer 21 control register ch. 2	R/W	00000000 <sub>B</sub>
003F <sub>H</sub>	PC20	8/16-bit PPG timer 20 control register ch. 2	R/W	00000000 <sub>B</sub>

(Continued)

Address	Register abbreviation	Register name	R/W	Initial value
0040 <sub>H</sub>	TMCSRH1	16-bit reload timer control status register upper ch. 1	R/W	00000000 <sub>B</sub>
0041 <sub>H</sub>	TMCSRL1	16-bit reload timer control status register lower ch. 1	R/W	00000000 <sub>B</sub>
0042 <sub>H</sub> , 0043 <sub>H</sub>	—	(Disabled)	—	—
0044 <sub>H</sub>	PCNTH1	16-bit PPG status control register upper ch. 1	R/W	00000000 <sub>B</sub>
0045 <sub>H</sub>	PCNTL1	16-bit PPG status control register lower ch. 1	R/W	00000000 <sub>B</sub>
0046 <sub>H</sub> , 0047 <sub>H</sub>	—	(Disabled)	—	—
0048 <sub>H</sub>	EIC00	External interrupt circuit control register ch. 0/ch. 1	R/W	00000000 <sub>B</sub>
0049 <sub>H</sub>	EIC10	External interrupt circuit control register ch. 2/ch. 3	R/W	00000000 <sub>B</sub>
004A <sub>H</sub>	EIC20	External interrupt circuit control register ch. 4/ch. 5	R/W	00000000 <sub>B</sub>
004B <sub>H</sub>	EIC30	External interrupt circuit control register ch. 6/ch. 7	R/W	00000000 <sub>B</sub>
004C <sub>H</sub>	EIC01	External interrupt circuit control register ch. 8/ch. 9	R/W	00000000 <sub>B</sub>
004D <sub>H</sub> to 004F <sub>H</sub>	—	(Disabled)	—	—
0050 <sub>H</sub>	SCR	LIN-UART serial control register	R/W	00000000 <sub>B</sub>
0051 <sub>H</sub>	SMR	LIN-UART serial mode register	R/W	00000000 <sub>B</sub>
0052 <sub>H</sub>	SSR	LIN-UART serial status register	R/W	00001000 <sub>B</sub>
0053 <sub>H</sub>	RDR/TDR	LIN-UART receive/transmit data register	R/W	00000000 <sub>B</sub>
0054 <sub>H</sub>	ESCR	LIN-UART extended status control register	R/W	00000100 <sub>B</sub>
0055 <sub>H</sub>	ECCR	LIN-UART extended communication control register	R/W	000000XX <sub>B</sub>
0056 <sub>H</sub>	SMC10	UART/SIO serial mode control register 1 ch. 0	R/W	00000000 <sub>B</sub>
0057 <sub>H</sub>	SMC20	UART/SIO serial mode control register 2 ch. 0	R/W	00100000 <sub>B</sub>
0058 <sub>H</sub>	SSR0	UART/SIO serial status and data register ch. 0	R/W	00000001 <sub>B</sub>
0059 <sub>H</sub>	TDR0	UART/SIO serial output data register ch. 0	R/W	00000000 <sub>B</sub>
005A <sub>H</sub>	RDR0	UART/SIO serial input data register ch. 0	R	00000000 <sub>B</sub>
005B <sub>H</sub> to 005F <sub>H</sub>	—	(Disabled)	—	—
0060 <sub>H</sub>	IBCR00	I <sup>2</sup> C bus control register 0	R/W	00000000 <sub>B</sub>
0061 <sub>H</sub>	IBCR10	I <sup>2</sup> C bus control register 1	R/W	00000000 <sub>B</sub>
0062 <sub>H</sub>	IBSR0	I <sup>2</sup> C bus status register	R/W	00000000 <sub>B</sub>
0063 <sub>H</sub>	IDDR0	I <sup>2</sup> C data register	R/W	00000000 <sub>B</sub>
0064 <sub>H</sub>	IAAR0	I <sup>2</sup> C address register	R/W	00000000 <sub>B</sub>
0065 <sub>H</sub>	ICCR0	I <sup>2</sup> C clock control register	R/W	00000000 <sub>B</sub>
0066 <sub>H</sub>	OPCUR	16-bit MPG output control register (upper)	R/W	00000000 <sub>B</sub>
0067 <sub>H</sub>	OPCLR	16-bit MPG output control register (lower)	R/W	00000000 <sub>B</sub>
0068 <sub>H</sub>	IPCUR	16-bit MPG input control register (upper)	R/W	00000000 <sub>B</sub>
0069 <sub>H</sub>	IPCLR	16-bit MPG input control register (lower)	R/W	00000000 <sub>B</sub>

*(Continued)*

Address	Register abbreviation	Register name	R/W	Initial value
006A <sub>H</sub>	NCCR	16-bit MPG noise cancellation control register	R/W	00000000 <sub>B</sub>
006B <sub>H</sub>	TCSR	16-bit MPG timer control status register	R/W	00000000 <sub>B</sub>
006C <sub>H</sub>	ADC1	8/10-bit A/D converter control register 1	R/W	00000000 <sub>B</sub>
006D <sub>H</sub>	ADC2	8/10-bit A/D converter control register 2	R/W	00000000 <sub>B</sub>
006E <sub>H</sub>	ADDH	8/10-bit A/D converter data register (upper)	R/W	00000000 <sub>B</sub>
006F <sub>H</sub>	ADDL	8/10-bit A/D converter data register (lower)	R/W	00000000 <sub>B</sub>
0070 <sub>H</sub>	—	(Disabled)	—	—
0071 <sub>H</sub>	FSR2	Flash memory status register 2	R/W	00000000 <sub>B</sub>
0072 <sub>H</sub>	FSR	Flash memory status register	R/W	00X0000 <sub>B</sub>
0073 <sub>H</sub>	SWRE0	Flash memory sector write control register 0	R/W	00000000 <sub>B</sub>
0074 <sub>H</sub>	FSR3	Flash memory status register 3	R	0000XXXX <sub>B</sub>
0075 <sub>H</sub>	—	(Disabled)	—	—
0076 <sub>H</sub>	WREN	Wild register address compare enable register	R/W	00000000 <sub>B</sub>
0077 <sub>H</sub>	WROR	Wild register data test setting register	R/W	00000000 <sub>B</sub>
0078 <sub>H</sub>	—	Mirror of register bank pointer (RP) and mirror of direct bank pointer (DP)	—	—
0079 <sub>H</sub>	ILR0	Interrupt level setting register 0	R/W	11111111 <sub>B</sub>
007A <sub>H</sub>	ILR1	Interrupt level setting register 1	R/W	11111111 <sub>B</sub>
007B <sub>H</sub>	ILR2	Interrupt level setting register 2	R/W	11111111 <sub>B</sub>
007C <sub>H</sub>	ILR3	Interrupt level setting register 3	R/W	11111111 <sub>B</sub>
007D <sub>H</sub>	ILR4	Interrupt level setting register 4	R/W	11111111 <sub>B</sub>
007E <sub>H</sub>	ILR5	Interrupt level setting register 5	R/W	11111111 <sub>B</sub>
007F <sub>H</sub>	—	(Disabled)	—	—
0F80 <sub>H</sub>	WRARH0	Wild register address setting register (upper) ch. 0	R/W	00000000 <sub>B</sub>
0F81 <sub>H</sub>	WRARL0	Wild register address setting register (lower) ch. 0	R/W	00000000 <sub>B</sub>
0F82 <sub>H</sub>	WRDR0	Wild register data setting register ch. 0	R/W	00000000 <sub>B</sub>
0F83 <sub>H</sub>	WRARH1	Wild register address setting register (upper) ch. 1	R/W	00000000 <sub>B</sub>
0F84 <sub>H</sub>	WRARL1	Wild register address setting register (lower) ch. 1	R/W	00000000 <sub>B</sub>
0F85 <sub>H</sub>	WRDR1	Wild register data setting register ch. 1	R/W	00000000 <sub>B</sub>
0F86 <sub>H</sub>	WRARH2	Wild register address setting register (upper) ch. 2	R/W	00000000 <sub>B</sub>
0F87 <sub>H</sub>	WRARL2	Wild register address setting register (lower) ch. 2	R/W	00000000 <sub>B</sub>
0F88 <sub>H</sub>	WRDR2	Wild register data setting register ch. 2	R/W	00000000 <sub>B</sub>
0F89 <sub>H</sub> to 0F91 <sub>H</sub>	—	(Disabled)	—	—

*(Continued)*

Address	Register abbreviation	Register name	R/W	Initial value
0F92 <sub>H</sub>	T01CR0	8/16-bit composite timer 01 status control register 0 ch. 0	R/W	00000000 <sub>B</sub>
0F93 <sub>H</sub>	T00CR0	8/16-bit composite timer 00 status control register 0 ch. 0	R/W	00000000 <sub>B</sub>
0F94 <sub>H</sub>	T01DR	8/16-bit composite timer 01 data register ch. 0	R/W	00000000 <sub>B</sub>
0F95 <sub>H</sub>	T00DR	8/16-bit composite timer 00 data register ch. 0	R/W	00000000 <sub>B</sub>
0F96 <sub>H</sub>	TMCR0	8/16-bit composite timer 00/01 timer mode control register ch. 0	R/W	00000000 <sub>B</sub>
0F97 <sub>H</sub>	T11CR0	8/16-bit composite timer 11 status control register 0 ch. 1	R/W	00000000 <sub>B</sub>
0F98 <sub>H</sub>	T10CR0	8/16-bit composite timer 10 status control register 0 ch. 1	R/W	00000000 <sub>B</sub>
0F99 <sub>H</sub>	T11DR	8/16-bit composite timer 11 data register ch. 1	R/W	00000000 <sub>B</sub>
0F9A <sub>H</sub>	T10DR	8/16-bit composite timer 10 data register ch. 1	R/W	00000000 <sub>B</sub>
0F9B <sub>H</sub>	TMCR1	8/16-bit composite timer 10/11 timer mode control register ch. 1	R/W	00000000 <sub>B</sub>
0F9C <sub>H</sub>	PPS01	8/16-bit PPG01 cycle setting buffer register ch. 0	R/W	11111111 <sub>B</sub>
0F9D <sub>H</sub>	PPS00	8/16-bit PPG00 cycle setting buffer register ch. 0	R/W	11111111 <sub>B</sub>
0F9E <sub>H</sub>	PDS01	8/16-bit PPG01 duty setting buffer register ch. 0	R/W	11111111 <sub>B</sub>
0F9F <sub>H</sub>	PDS00	8/16-bit PPG00 duty setting buffer register ch. 0	R/W	11111111 <sub>B</sub>
0FA0 <sub>H</sub>	PPS11	8/16-bit PPG11 cycle setting buffer register ch. 1	R/W	11111111 <sub>B</sub>
0FA1 <sub>H</sub>	PPS10	8/16-bit PPG10 cycle setting buffer register ch. 1	R/W	11111111 <sub>B</sub>
0FA2 <sub>H</sub>	PDS11	8/16-bit PPG11 duty setting buffer register ch. 1	R/W	11111111 <sub>B</sub>
0FA3 <sub>H</sub>	PDS10	8/16-bit PPG10 duty setting buffer register ch. 1	R/W	11111111 <sub>B</sub>
0FA4 <sub>H</sub>	PPGS	8/16-bit PPG startup register	R/W	00000000 <sub>B</sub>
0FA5 <sub>H</sub>	REVC	8/16-bit PPG output reverse register	R/W	00000000 <sub>B</sub>
0FA6 <sub>H</sub>	PPS21	8/16-bit PPG21 cycle setting buffer register ch. 2	R/W	11111111 <sub>B</sub>
0FA7 <sub>H</sub>	PPS20	8/16-bit PPG20 cycle setting buffer register ch. 2	R/W	11111111 <sub>B</sub>
0FA8 <sub>H</sub>	TMRH1	16-bit timer register (upper) ch. 1	R/W	00000000 <sub>B</sub>
	TMRLRH1	16-bit reload register (upper) ch. 1		
0FA9 <sub>H</sub>	TMRL1	16-bit timer register (lower) ch. 1	R/W	00000000 <sub>B</sub>
	TMRLRL1	16-bit reload register (lower) ch. 1		
0FAA <sub>H</sub>	PDS21	8/16-bit PPG21 duty setting buffer register ch. 2	R/W	11111111 <sub>B</sub>
0FAB <sub>H</sub>	PDS20	8/16-bit PPG20 duty setting buffer register ch. 2	R/W	11111111 <sub>B</sub>
0FAC <sub>H</sub> to 0FAF <sub>H</sub>	—	(Disabled)	—	—
0FB0 <sub>H</sub>	PDCRH1	16-bit PPG down counter register (upper) ch. 1	R	00000000 <sub>B</sub>
0FB1 <sub>H</sub>	PDCRL1	16-bit PPG down counter register (lower) ch. 1	R	00000000 <sub>B</sub>
0FB2 <sub>H</sub>	PCSRH1	16-bit PPG cycle setting buffer register (upper) ch. 1	R/W	11111111 <sub>B</sub>
0FB3 <sub>H</sub>	PCSRL1	16-bit PPG cycle setting buffer register (lower) ch. 1	R/W	11111111 <sub>B</sub>
0FB4 <sub>H</sub>	PDUTH1	16-bit PPG duty setting buffer register (upper) ch. 1	R/W	11111111 <sub>B</sub>
0FB5 <sub>H</sub>	PDUTL1	16-bit PPG duty setting buffer register (lower) ch. 1	R/W	11111111 <sub>B</sub>

*(Continued)*

Address	Register abbreviation	Register name	R/W	Initial value
0FB6 <sub>H</sub> to 0FBB <sub>H</sub>	—	(Disabled)	—	—
0FBC <sub>H</sub>	BGR1	LIN-UART baud rate generator register 1	R/W	00000000 <sub>B</sub>
0FBD <sub>H</sub>	BGR0	LIN-UART baud rate generator register 0	R/W	00000000 <sub>B</sub>
0FBE <sub>H</sub>	PSSR0	UART/SIO dedicated baud rate generator prescaler select register ch. 0	R/W	00000000 <sub>B</sub>
0FBF <sub>H</sub>	BRSR0	UART/SIO dedicated baud rate generator baud rate setting register ch. 0	R/W	00000000 <sub>B</sub>
0FC0 <sub>H</sub> to 0FC2 <sub>H</sub>	—	(Disabled)	—	—
0FC3 <sub>H</sub>	AIDRL	A/D input disable register (lower)	R/W	00000000 <sub>B</sub>
0FC4 <sub>H</sub>	OPDBRH0	16-bit MPG output data buffer register (upper) ch. 0	R/W	00000000 <sub>B</sub>
0FC5 <sub>H</sub>	OPDBRL0	16-bit MPG output data buffer register (lower) ch. 0	R/W	00000000 <sub>B</sub>
0FC6 <sub>H</sub>	OPDBRH1	16-bit MPG output data buffer register (upper) ch. 1	R/W	00000000 <sub>B</sub>
0FC7 <sub>H</sub>	OPDBRL1	16-bit MPG output data buffer register (lower) ch. 1	R/W	00000000 <sub>B</sub>
0FC8 <sub>H</sub>	OPDBRH2	16-bit MPG output data buffer register (upper) ch. 2	R/W	00000000 <sub>B</sub>
0FC9 <sub>H</sub>	OPDBRL2	16-bit MPG output data buffer register (lower) ch. 2	R/W	00000000 <sub>B</sub>
0FCA <sub>H</sub>	OPDBRH3	16-bit MPG output data buffer register (upper) ch. 3	R/W	00000000 <sub>B</sub>
0FCB <sub>H</sub>	OPDBRL3	16-bit MPG output data buffer register (lower) ch. 3	R/W	00000000 <sub>B</sub>
0FCC <sub>H</sub>	OPDBRH4	16-bit MPG output data buffer register (upper) ch. 4	R/W	00000000 <sub>B</sub>
0FCD <sub>H</sub>	OPDBRL4	16-bit MPG output data buffer register (lower) ch. 4	R/W	00000000 <sub>B</sub>
0FCE <sub>H</sub>	OPDBRH5	16-bit MPG output data buffer register (upper) ch. 5	R/W	00000000 <sub>B</sub>
0FCF <sub>H</sub>	OPDBRL5	16-bit MPG output data buffer register (lower) ch. 5	R/W	00000000 <sub>B</sub>
0FD0 <sub>H</sub>	OPDBRH6	16-bit MPG output data buffer register (upper) ch. 6	R/W	00000000 <sub>B</sub>
0FD1 <sub>H</sub>	OPDBRL6	16-bit MPG output data buffer register (lower) ch. 6	R/W	00000000 <sub>B</sub>
0FD2 <sub>H</sub>	OPDBRH7	16-bit MPG output data buffer register (upper) ch. 7	R/W	00000000 <sub>B</sub>
0FD3 <sub>H</sub>	OPDBRL7	16-bit MPG output data buffer register (lower) ch. 7	R/W	00000000 <sub>B</sub>
0FD4 <sub>H</sub>	OPDBRH8	16-bit MPG output data buffer register (upper) ch. 8	R/W	00000000 <sub>B</sub>
0FD5 <sub>H</sub>	OPDBRL8	16-bit MPG output data buffer register (lower) ch. 8	R/W	00000000 <sub>B</sub>
0FD6 <sub>H</sub>	OPDBRH9	16-bit MPG output data buffer register (upper) ch. 9	R/W	00000000 <sub>B</sub>
0FD7 <sub>H</sub>	OPDBRL9	16-bit MPG output data buffer register (lower) ch. 9	R/W	00000000 <sub>B</sub>
0FD8 <sub>H</sub>	OPDBRHA	16-bit MPG output data buffer register (upper) ch. A	R/W	00000000 <sub>B</sub>
0FD9 <sub>H</sub>	OPDBRLA	16-bit MPG output data buffer register (lower) ch. A	R/W	00000000 <sub>B</sub>
0FDA <sub>H</sub>	OPDBRHB	16-bit MPG output data buffer register (upper) ch. B	R/W	00000000 <sub>B</sub>
0FDB <sub>H</sub>	OPDBRLB	16-bit MPG output data buffer register (lower) ch. B	R/W	00000000 <sub>B</sub>
0FDC <sub>H</sub>	OPDUR	16-bit MPG output data register (upper)	R	0000XXXX <sub>B</sub>
0FDD <sub>H</sub>	OPDLR	16-bit MPG output data register (lower)	R	XXXXXXXX <sub>B</sub>
0FDE <sub>H</sub>	CPCUR	16-bit MPG compare clear register (upper)	R/W	XXXXXXXX <sub>B</sub>
0FDF <sub>H</sub>	CPCLR	16-bit MPG compare clear register (lower)	R/W	XXXXXXXX <sub>B</sub>

*(Continued)*

(Continued)

Address	Register abbreviation	Register name	R/W	Initial value
0FE0 <sub>H</sub> , 0FE1 <sub>H</sub>	—	(Disabled)	—	—
0FE2 <sub>H</sub>	TMBUR	16-bit MPG timer buffer register (upper)	R	XXXXXXXX <sub>B</sub>
0FE3 <sub>H</sub>	TMBLR	16-bit MPG timer buffer register (lower)	R	XXXXXXXX <sub>B</sub>
0FE4 <sub>H</sub>	CRTH	Main CR clock trimming register (upper)	R/W	0XXXXXXXX <sub>B</sub>
0FE5 <sub>H</sub>	CRTL	Main CR clock trimming register (lower)	R/W	00XXXXXXXX <sub>B</sub>
0FE6 <sub>H</sub> , 0FE7 <sub>H</sub>	—	(Disabled)	—	—
0FE8 <sub>H</sub>	SYSC	System configuration register	R/W	11000011 <sub>B</sub>
0FE9 <sub>H</sub>	CMCR	Clock monitoring control register	R/W	00000000 <sub>B</sub>
0FEA <sub>H</sub>	CMDR	Clock monitoring data register	R	00000000 <sub>B</sub>
0FEB <sub>H</sub>	WDTH	Watchdog timer selection ID register (upper)	R	XXXXXXXX <sub>B</sub>
0FEC <sub>H</sub>	WDTL	Watchdog timer selection ID register (lower)	R	XXXXXXXX <sub>B</sub>
0FED <sub>H</sub>	—	(Disabled)	—	—
0FEE <sub>H</sub>	ILSR	Input level select register	R/W	00000000 <sub>B</sub>
0FEF <sub>H</sub>	WICR	Interrupt pin control register	R/W	01000000 <sub>B</sub>
0FF0 <sub>H</sub> to 0FFF <sub>H</sub>	—	(Disabled)	—	—

■ R/W access symbols



- R/W : Readable / Writable
- R : Read only
- W : Write only

■ Initial value symbols

- 0 : The initial value of this bit is “0”.
- 1 : The initial value of this bit is “1”.
- X : The initial value of this bit is indeterminate.

**Note:** Do not write to an address that is “(Disabled)”. If a “(Disabled)” address is read, an indeterminate value is returned.

## 12. Interrupt Source Table

Interrupt source	Interrupt request number	Vector table address		Bit name of interrupt level setting register	Priority order of interrupt sources of the same level (occurring simultaneously)
		Upper	Lower		
External interrupt ch. 0, ch. 4	IRQ00	FFFA <sub>H</sub>	FFFB <sub>H</sub>	L00 [1:0]	<div style="text-align: center;">High</div>   <div style="text-align: center;">Low</div>
External interrupt ch. 1, ch. 5	IRQ01	FFF8 <sub>H</sub>	FFF9 <sub>H</sub>	L01 [1:0]	
External interrupt ch. 2, ch. 6	IRQ02	FFF6 <sub>H</sub>	FFF7 <sub>H</sub>	L02 [1:0]	
External interrupt ch. 3, ch. 7	IRQ03	FFF4 <sub>H</sub>	FFF5 <sub>H</sub>	L03 [1:0]	
UART/SIO ch. 0, MPG (DTTI)	IRQ04	FFF2 <sub>H</sub>	FFF3 <sub>H</sub>	L04 [1:0]	
8/16-bit composite timer ch. 0 (lower)	IRQ05	FFF0 <sub>H</sub>	FFF1 <sub>H</sub>	L05 [1:0]	
8/16-bit composite timer ch. 0 (upper)	IRQ06	FFEE <sub>H</sub>	FFEF <sub>H</sub>	L06 [1:0]	
LIN-UART (reception)	IRQ07	FFEC <sub>H</sub>	FFED <sub>H</sub>	L07 [1:0]	
LIN-UART (transmission)	IRQ08	FFEA <sub>H</sub>	FFEB <sub>H</sub>	L08 [1:0]	
8/16-bit PPG ch. 1 (lower)	IRQ09	FFE8 <sub>H</sub>	FFE9 <sub>H</sub>	L09 [1:0]	
8/16-bit PPG ch. 1 (upper)	IRQ10	FFE6 <sub>H</sub>	FFE7 <sub>H</sub>	L10 [1:0]	
8/16-bit PPG ch. 2 (upper)	IRQ11	FFE4 <sub>H</sub>	FFE5 <sub>H</sub>	L11 [1:0]	
8/16-bit PPG ch. 0 (upper)	IRQ12	FFE2 <sub>H</sub>	FFE3 <sub>H</sub>	L12 [1:0]	
8/16-bit PPG ch. 0 (lower)	IRQ13	FFE0 <sub>H</sub>	FFE1 <sub>H</sub>	L13 [1:0]	
8/16-bit composite timer ch. 1 (upper)	IRQ14	FFDE <sub>H</sub>	FFDF <sub>H</sub>	L14 [1:0]	
8/16-bit PPG ch. 2 (lower)	IRQ15	FFDC <sub>H</sub>	FFDD <sub>H</sub>	L15 [1:0]	
16-bit reload timer ch. 1, MPG (write timing/compare clear), I <sup>2</sup> C	IRQ16	FFDA <sub>H</sub>	FFDB <sub>H</sub>	L16 [1:0]	
16-bit PPG timer ch. 1, MPG (position detection/compare match)	IRQ17	FFD8 <sub>H</sub>	FFD9 <sub>H</sub>	L17 [1:0]	
8/10-bit A/D converter	IRQ18	FFD6 <sub>H</sub>	FFD7 <sub>H</sub>	L18 [1:0]	
Time-base timer	IRQ19	FFD4 <sub>H</sub>	FFD5 <sub>H</sub>	L19 [1:0]	
Watch prescaler	IRQ20	FFD2 <sub>H</sub>	FFD3 <sub>H</sub>	L20 [1:0]	
External interrupt ch. 8, ch. 9	IRQ21	FFD0 <sub>H</sub>	FFD1 <sub>H</sub>	L21 [1:0]	
8/16-bit composite timer ch. 1 (lower)	IRQ22	FFCE <sub>H</sub>	FFCF <sub>H</sub>	L22 [1:0]	
Flash memory	IRQ23	FFCC <sub>H</sub>	FFCD <sub>H</sub>	L23 [1:0]	

## 13. Electrical Characteristics

### 13.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1	$V_{CC}$	$V_{SS} - 0.3$	$V_{SS} + 6$	V	
Input voltage*1	$V_I$	$V_{SS} - 0.3$	$V_{SS} + 6$	V	*2
Output voltage*1	$V_O$	$V_{SS} - 0.3$	$V_{SS} + 6$	V	*2
Maximum clamp current	$I_{CLAMP}$	-2	+2	mA	Applicable to specific pins*3
Total maximum clamp current	$\sum  I_{CLAMP} $	—	20	mA	Applicable to specific pins*3
"L" level maximum output current	$I_{OL1}$	—	15	mA	Other than P62 to P67
	$I_{OL2}$	—	15		P62 to P67
"L" level average current	$I_{OLAV1}$	—	4	mA	Other than P62 to P67 Average output current = operating current × operating ratio (1 pin)
	$I_{OLAV2}$	—	12		P62 to P67 Average output current = operating current × operating ratio (1 pin)
"L" level total maximum output current	$\sum I_{OL}$	—	100	mA	
"L" level total average output current	$\sum I_{OLAV}$	—	50	mA	Total average output current = operating current × operating ratio (Total number of pins)
"H" level maximum output current	$I_{OH1}$	—	-15	mA	Other than P62 to P67
	$I_{OH2}$	—	-15		P62 to P67
"H" level average current	$I_{OHAV1}$	—	-4	mA	Other than P62 to P67 Average output current = operating current × operating ratio (1 pin)
	$I_{OHAV2}$	—	-8		P62 to P67 Average output current = operating current × operating ratio (1 pin)
"H" level total maximum output current	$\sum I_{OH}$	—	-100	mA	
"H" level total average output current	$\sum I_{OHAV}$	—	-50	mA	Total average output current = operating current × operating ratio (Total number of pins)
Power consumption	$P_d$	—	320	mW	
Operating temperature	$T_A$	-40	+85	°C	
Storage temperature	$T_{stg}$	-55	+150	°C	

(Continued)

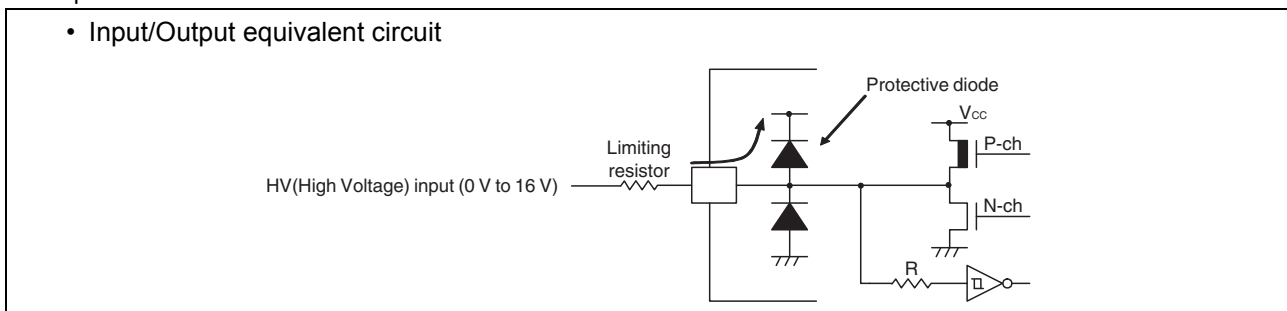
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\*1: The parameter is based on  $V_{SS} = 0.0\text{ V}$ .

\*2:  $V_I$  and  $V_O$  must not exceed  $V_{CC} + 0.3\text{ V}$ .  $V_I$  must not exceed the rated voltage. However, if the maximum current to/from an input is limited by means of an external component, the  $I_{CLAMP}$  rating is used instead of the  $V_I$  rating.

\*3: Applicable to the following pins: P00 to P07, P10, P11, P13 to P17, P62 to P67, PF0, PF1, PG1 and PG2

- Use under recommended operating conditions.
- Use with DC voltage (current).
- The HV (High Voltage) signal is an input signal exceeding the  $V_{CC}$  voltage. Always connect a limiting resistor between the HV (High Voltage) signal and the microcontroller before applying the HV (High Voltage) signal.
- The value of the limiting resistor should be set to a value at which the current to be input to the microcontroller pin when the HV (High Voltage) signal is input is below the standard value, irrespective of whether the current is transient current or stationary current.
- When the microcontroller drive current is low, such as in low power consumption modes, the HV (High Voltage) input potential may pass through the protective diode to increase the potential of the  $V_{CC}$  pin, affecting other devices.
- If the HV (High Voltage) signal is input when the microcontroller power supply is off (not fixed at 0 V), since power is supplied from the pins, incomplete operations may be executed.
- If the HV (High Voltage) input is input after power-on, since power is supplied from the pins, the voltage of power supply may not be sufficient to enable a power-on reset.
- Do not leave the HV (High Voltage) input pin unconnected.
- Example of a recommended circuit



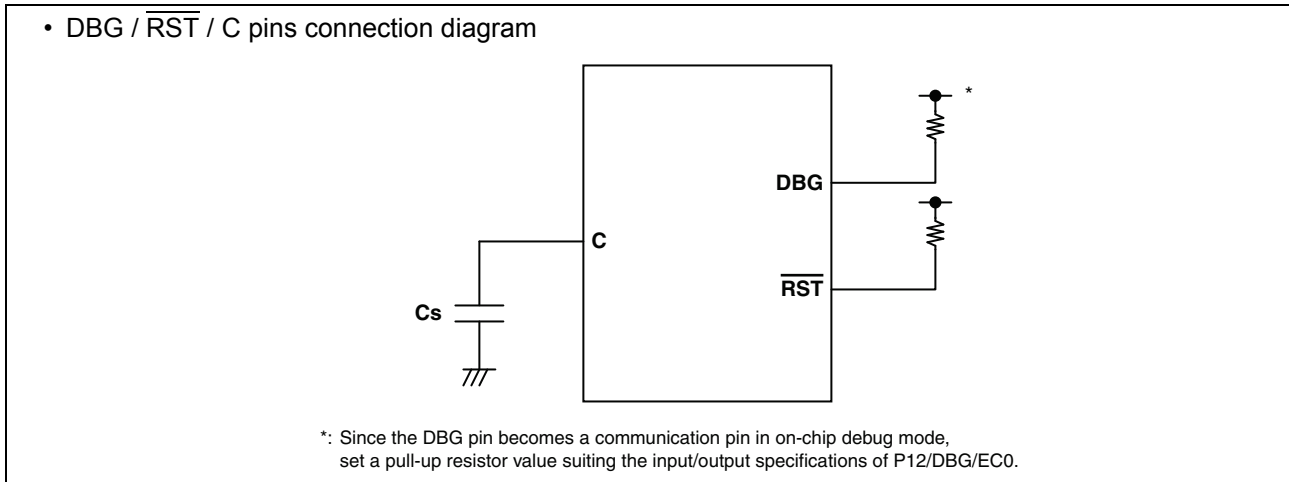
**WARNING:** Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

## 13.2 Recommended Operating Conditions

( $V_{SS} = 0.0\text{ V}$ )

Parameter	Symbol	Value		Unit	Remarks	
		Min	Max			
Power supply voltage	$V_{CC}$	2.4*1*2	5.5*1	V	In normal operation	Other than on-chip debug mode
		2.3	5.5		Hold condition in stop mode	
		2.9	5.5		In normal operation	On-chip debug mode
		2.3	5.5		Hold condition in stop mode	
Smoothing capacitor	$C_S$	0.022	1	$\mu\text{F}$	*3	
Operating temperature	$T_A$	-40	+85	$^{\circ}\text{C}$	Other than on-chip debug mode	
		+5	+35		On-chip debug mode	

- \*1: The value varies depending on the operating frequency, the machine clock and the analog guaranteed range.
- \*2: This value becomes 2.88 V when the low-voltage detection reset is used.
- \*3: Use a ceramic capacitor or a capacitor with equivalent frequency characteristics. The bypass capacitor for the  $V_{CC}$  pin must have a capacitance larger than  $C_S$ . For the connection to a smoothing capacitor  $C_S$ , see the diagram below. To prevent the device from unintentionally entering an unknown mode due to noise, minimize the distance between the C pin and  $C_S$  and the distance between  $C_S$  and the  $V_{SS}$  pin when designing the layout of a printed circuit board.



**WARNING:** The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their representatives beforehand.

### 13.3 DC Characteristics

( $V_{CC} = 5.0 V \pm 10\%$ ,  $V_{SS} = 0.0 V$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ )

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	$V_{IH1}$	P04, P16, P60, P61	*1	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	When CMOS input level (hysteresis input) is selected
	$V_{IHS}$	P00 to P07, P10 to P17, P60 to P67, PF0, PF1, PG1, PG2	*1	$0.8 V_{CC}$	—	$V_{CC} + 0.3$	V	Hysteresis input
	$V_{IHM}$	PF2	—	$0.7 V_{CC}$	—	$V_{CC} + 0.3$	V	Hysteresis input
"L" level input voltage	$V_{IL}$	P04, P16, P60, P61	*1	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	When CMOS input level (hysteresis input) is selected
	$V_{ILS}$	P00 to P07, P10 to P17, P60 to P67, PF0, PF1, PG1, PG2	*1	$V_{SS} - 0.3$	—	$0.2 V_{CC}$	V	Hysteresis input
	$V_{ILM}$	PF2	—	$V_{SS} - 0.3$	—	$0.3 V_{CC}$	V	Hysteresis input
Open-drain output application voltage	$V_D$	P12, P60, P61, PF2	—	$V_{SS} - 0.3$	—	$V_{SS} + 5.5$	V	
"H" level output voltage	$V_{OH1}$	Output pins other than P12, P60 to P67, PF2	$I_{OH} = -4 \text{ mA}$	$V_{CC} - 0.5$	—	—	V	
	$V_{OH2}$	P62 to P67	$I_{OH} = -8 \text{ mA}$	$V_{CC} - 0.5$	—	—	V	
"L" level output voltage	$V_{OL1}$	Output pins other than P62 to P67	$I_{OL} = 4 \text{ mA}$	—	—	0.4	V	
	$V_{OL2}$	P62 to P67	$I_{OL} = 12 \text{ mA}$	—	—	0.4	V	
Input leak current (Hi-Z output leak current)	$I_{LI}$	All input pins	$0.0 V < V_I < V_{CC}$	-5	—	+5	$\mu A$	When pull-up resistance is disabled
Pull-up resistance	$R_{PULL}$	P00 to P07, P10, P11, P13 to P17, PG1, PG2	$V_I = 0 V$	25	50	100	$k\Omega$	When pull-up resistance is enabled
Input capacitance	$C_{IN}$	Other than $V_{CC}$ and $V_{SS}$	$f = 1 \text{ MHz}$	—	5	15	pF	

(Continued)

$(V_{CC} = 5.0 V \pm 10\%, V_{SS} = 0.0 V, T_A = -40^\circ C \text{ to } +85^\circ C)$ 

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current*2	I <sub>CC</sub>	V <sub>CC</sub> (External clock operation)	V <sub>CC</sub> = 5.5 V F <sub>CH</sub> = 32 MHz F <sub>MP</sub> = 16 MHz Main clock mode (divided by 2)	—	13	17	mA	Flash memory product (except writing and erasing)
			—	20.5	26.5	mA		Flash memory product (at writing and erasing)
			—	15	21		mA	At A/D conversion
	I <sub>CCS</sub>		V <sub>CC</sub> = 5.5 V F <sub>CH</sub> = 32 MHz F <sub>MP</sub> = 16 MHz Main sleep mode (divided by 2)	—	5.5	9		mA
	I <sub>CCL</sub>		V <sub>CC</sub> = 5.5 V F <sub>CL</sub> = 32 kHz F <sub>MPL</sub> = 16 kHz Subclock mode (divided by 2) T <sub>A</sub> = +25°C	—	65	153	μA	
	I <sub>CCLS</sub>		V <sub>CC</sub> = 5.5 V F <sub>CL</sub> = 32 kHz F <sub>MPL</sub> = 16 kHz Subsleep mode (divided by 2) T <sub>A</sub> = +25°C	—	10	84		μA
	I <sub>CCT</sub>		V <sub>CC</sub> = 5.5 V F <sub>CL</sub> = 32 kHz Watch mode Main stop mode T <sub>A</sub> = +25°C	—	5	30	μA	
	I <sub>CCMCR</sub>		V <sub>CC</sub>	V <sub>CC</sub> = 5.5 V F <sub>CRH</sub> = 12.5 MHz F <sub>MP</sub> = 12.5 MHz Main CR clock mode	—	10		13.2
I <sub>CCSCR</sub>	V <sub>CC</sub> = 5.5 V Sub-CR clock mode (divided by 2) T <sub>A</sub> = +25°C	—		110	410	μA		

*(Continued)*

(Continued)

 ( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )

Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks
				Min	Typ	Max		
Power supply current*2	$I_{CCTS}$	$V_{CC}$ (External clock operation)	$V_{CC} = 5.5\text{ V}$ $F_{CH} = 32\text{ MHz}$ Time-base timer mode $T_A = +25^\circ\text{C}$	—	1.1	3	mA	
	$I_{CCH}$		$V_{CC} = 5.5\text{ V}$ Substop mode $T_A = +25^\circ\text{C}$	—	3.5	22.5	$\mu\text{A}$	
	$I_{LVD}$	$V_{CC}$	Current consumption for low-voltage detection circuit only	—	37	54	$\mu\text{A}$	
	$I_{CRH}$		Current consumption for the main CR oscillator	—	0.5	0.6	mA	
	$I_{CRL}$		Current consumption for the sub-CR oscillator oscillating at 100 kHz	—	20	72	$\mu\text{A}$	

\*1: The input levels of P04, P16, P60 and P61 can be switched between "CMOS input level" and "hysteresis input level". The input level selection register (ILSR) is used to switch between the two input levels.

\*2: • The power supply current is determined by the external clock. When the low-voltage detection option is selected, the power-supply current will be the sum of adding the current consumption of the low-voltage detection circuit ( $I_{LVD}$ ) to one of the value from  $I_{CC}$  to  $I_{CCH}$ . In addition, when both the low-voltage detection option and the CR oscillator are selected, the power supply current will be the sum of adding up the current consumption of the low-voltage detection circuit, the current consumption of the CR oscillators ( $I_{CRH}$ ,  $I_{CRL}$ ) and a specified value. In on-chip debug mode, the CR oscillator ( $I_{CRH}$ ) and the low-voltage detection circuit are always enabled, and current consumption therefore increases accordingly.

- See "4. AC Characteristics: (1) Clock Timing" for  $F_{CH}$  and  $F_{CL}$ .
- See "4. AC Characteristics: (2) Source Clock/Machine Clock" for  $F_{MP}$  and  $F_{MPL}$ .

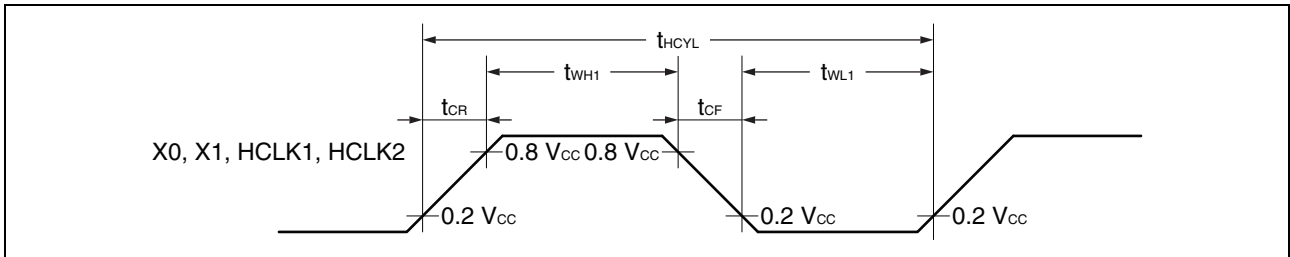
## 13.4 AC Characteristics

### 13.4.1 Clock Timing

( $V_{CC} = 2.4\text{ V to }5.5\text{ V}$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40^\circ\text{C to }+85^\circ\text{C}$ )

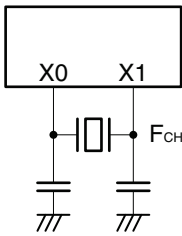
Parameter	Symbol	Pin name	Condition	Value			Unit	Remarks		
				Min	Typ	Max				
Clock frequency	$F_{CH}$	X0, X1	—	1	—	16.25	MHz	When the main oscillation circuit is used		
		X0	X1: open	1	—	12	MHz	When the main external clock is used		
		X0, X1	*	1	—	32.5	MHz			
		HCLK1, HCLK2	—	1	—	32.5	MHz			
	$F_{CRH}$	—	—	—	12.25	12.5	12.75	MHz	When the main CR clock is used $T_A = -10^\circ\text{C to }+85^\circ\text{C}$	
					9.8	10	10.2	MHz		
					7.84	8	8.16	MHz		
					0.98	1	1.02	MHz		
		—	—	—	—	12.1875	12.5	12.8125	MHz	When the main CR clock is used $T_A = -40^\circ\text{C to }-10^\circ\text{C}$
						9.75	10	10.25	MHz	
						7.8	8	8.2	MHz	
						0.975	1	1.025	MHz	
	$F_{CL}$	X0A, X1A	—	—	—	32.768	—	kHz	When the sub-oscillation circuit is used	
—					32.768	—	kHz	When the sub-external clock is used		
$F_{CRL}$	—	—	—	50	100	200	kHz	When the sub-CR clock is used		
Clock cycle time	$t_{HCYL}$	X0, X1	—	61.5	—	1000	ns	When the main oscillation circuit is used		
		X0	X1: open	83.4	—	1000	ns	When the external clock is used		
		X0, X1	*	30.8	—	1000	ns			
		HCLK1, HCLK2	—	30.8	—	1000	ns			
	$t_{LCYL}$	X0A, X1A	—	—	30.5	—	$\mu\text{s}$	When the subclock is used		
Input clock pulse width	$t_{WH1}$ $t_{WL1}$	X0	X1: open	33.4	—	—	ns	When the external clock is used, the duty ratio should range between 40% and 60%.		
		X0, X1	*	12.4	—	—	ns			
	$t_{WH2}$ $t_{WL2}$	X0A	—	—	15.2	—	$\mu\text{s}$			
Input clock rise time and fall time	$t_{CR}$ $t_{CF}$	X0	X1: open	—	—	5	ns	When the external clock is used		
		X0, X1	*	—	—	5	ns			
	HCLK1, HCLK2	—	—	—	5	ns				
CR oscillation start time	$t_{CRHWK}$	—	—	—	—	80	$\mu\text{s}$	When the main CR clock is used		
	$t_{CRLWK}$	—	—	—	—	10	$\mu\text{s}$	When the sub-CR clock is used		

\*: The external clock signal is input to X0 and the inverted external clock signal to X1.

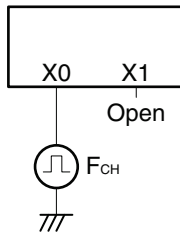


• Figure of main clock input port external connection

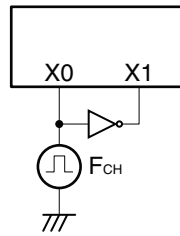
When a crystal oscillator or a ceramic oscillator is used



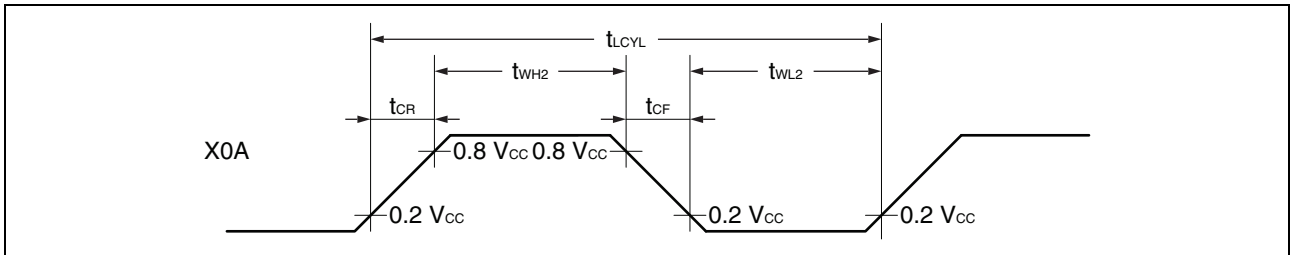
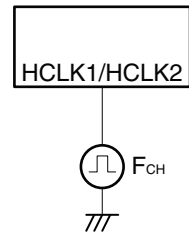
When the external clock is used (X1 is open)



When the external clock is used

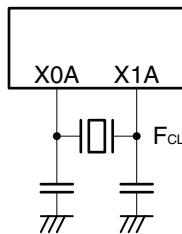


When the external clock is used

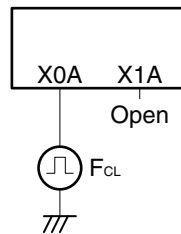


• Figure of subclock input port external connection

When a crystal oscillator or a ceramic oscillator is used



When the external clock is used



**13.4.2 Source Clock/Machine Clock**
 $(V_{CC} = 5.0\text{ V} \pm 10\%, V_{SS} = 0.0\text{ V}, T_A = -40^\circ\text{C to } +85^\circ\text{C})$ 

Parameter	Symbol	Pin name	Value			Unit	Remarks
			Min	Typ	Max		
Source clock cycle time*1	$t_{SCLK}$	—	61.5	—	2000	ns	When the main external clock is used Min: $F_{CH} = 32.5\text{ MHz}$ , divided by 2 Max: $F_{CH} = 1\text{ MHz}$ , divided by 2
			80	—	1000	ns	When the main CR clock is used Min: $F_{CRH} = 12.5\text{ MHz}$ Max: $F_{CRH} = 1\text{ MHz}$
			—	61	—	$\mu\text{s}$	When the sub-oscillation clock is used $F_{CL} = 32.768\text{ kHz}$ , divided by 2
			—	20	—	$\mu\text{s}$	When the sub-CR clock is used $F_{CRL} = 100\text{ kHz}$ , divided by 2
Source clock frequency	$F_{SP}$	—	0.5	—	16.25	MHz	When the main oscillation clock is used
			1	—	12.5	MHz	When the main CR clock is used
	—		16.384	—	kHz	When the sub-oscillation clock is used	
	$F_{SPL}$		—	50	—	kHz	When the sub-CR clock is used $F_{CRL} = 100\text{ kHz}$ , divided by 2
Machine clock cycle time*2 (minimum instruction execution time)	$t_{MCLK}$	—	61.5	—	32000	ns	When the main oscillation clock is used Min: $F_{SP} = 16.25\text{ MHz}$ , no division Max: $F_{SP} = 0.5\text{ MHz}$ , divided by 16
			80	—	16000	ns	When the main CR clock is used Min: $F_{SP} = 12.5\text{ MHz}$ Max: $F_{SP} = 1\text{ MHz}$ , divided by 16
			61	—	976.5	$\mu\text{s}$	When the sub-oscillation clock is used Min: $F_{SPL} = 16.384\text{ kHz}$ , no division Max: $F_{SPL} = 16.384\text{ kHz}$ , divided by 16
			20	—	320	$\mu\text{s}$	When the sub-CR clock is used Min: $F_{SPL} = 50\text{ kHz}$ , no division Max: $F_{SPL} = 50\text{ kHz}$ , divided by 16
Machine clock frequency	$F_{MP}$	—	0.031	—	16.25	MHz	When the main oscillation clock is used
			0.0625	—	12.5	MHz	When the main CR clock is used
	$F_{MPL}$		1.024	—	16.384	kHz	When the sub-oscillation clock is used
			3.125	—	50	kHz	When the sub-CR clock is used $F_{CRL} = 100\text{ kHz}$

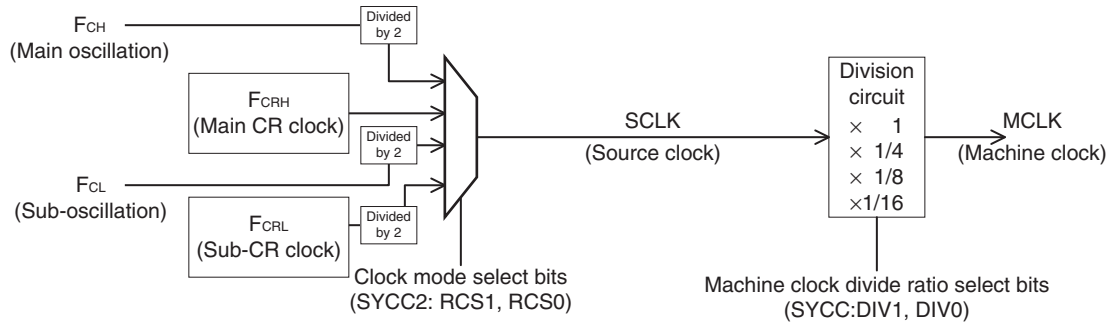
\*1: This is the clock before it is divided according to the division ratio set by the machine clock divide ratio select bits (SYCC:DIV1 and DIV0). This source clock is divided to become a machine clock according to the divide ratio set by the machine clock divide ratio select bits (SYCC:DIV1 and DIV0). In addition, a source clock can be selected from the following.

- Main clock divided by 2
- Main CR clock
- Subclock divided by 2
- Sub-CR clock divided by 2

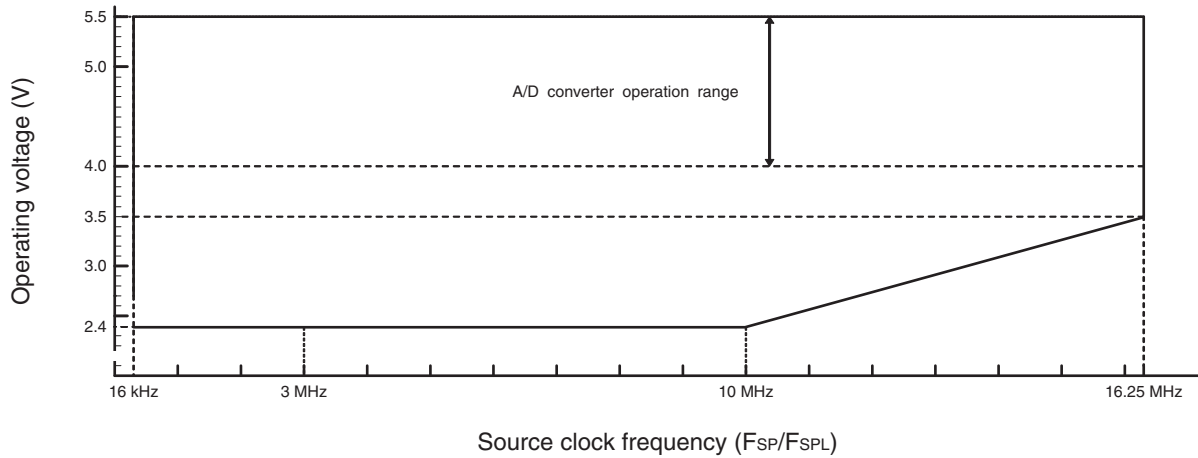
\*2: This is the operating clock of the microcontroller. A machine clock can be selected from the following.

- Source clock (no division)
- Source clock divided by 4
- Source clock divided by 8
- Source clock divided by 16

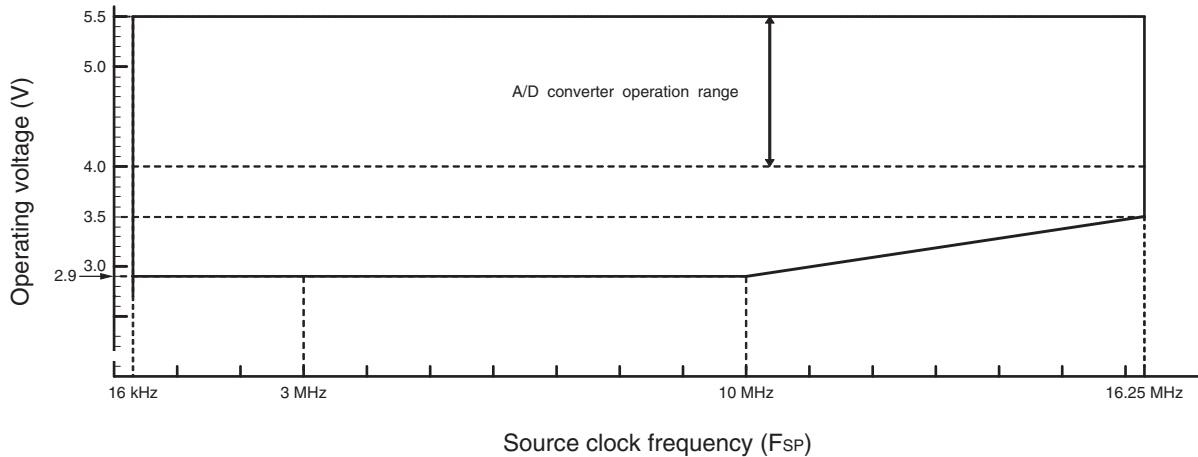
• Schematic diagram of the clock generation block



• Operating voltage - Operating frequency (When  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )  
MB95330H (without the on-chip debug function)



• Operating voltage - Operating frequency (When  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )  
MB95330H (with the on-chip debug function)



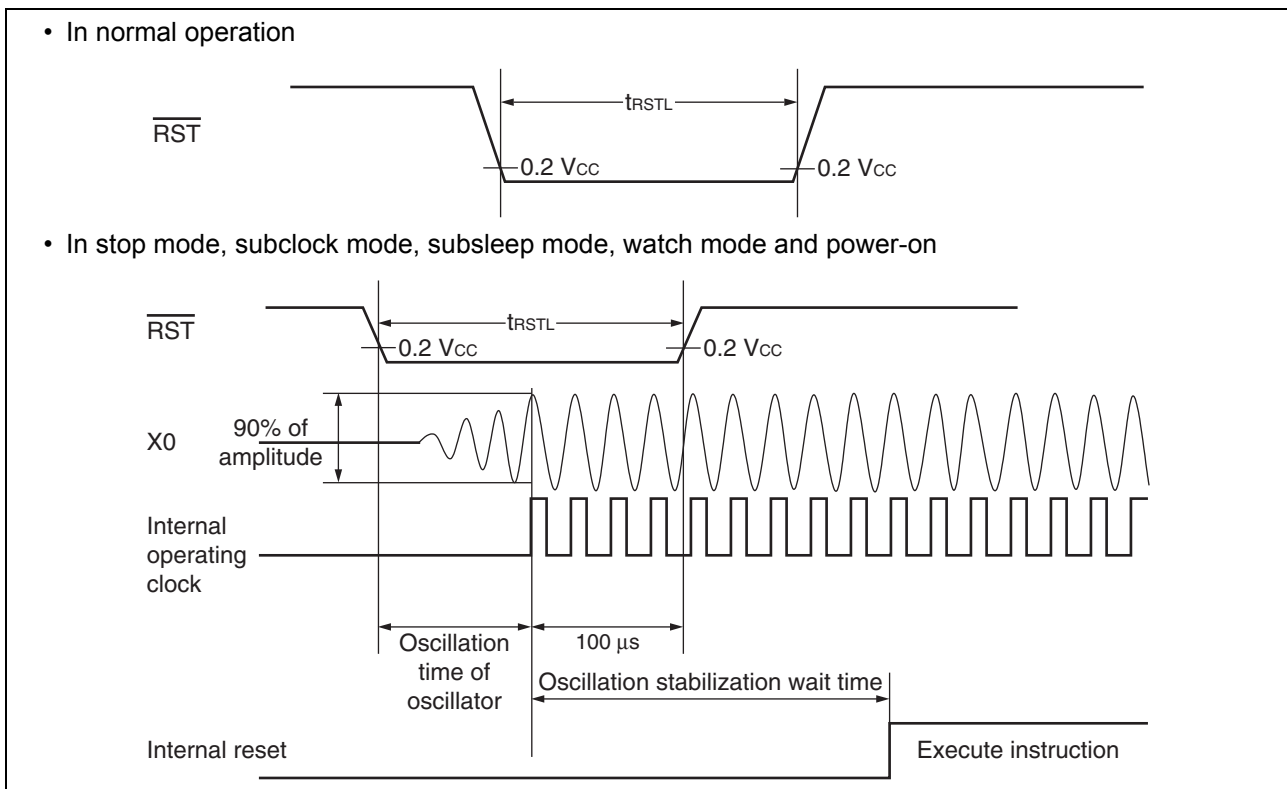
### 13.4.3 External Reset

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )

Parameter	Symbol	Value		Unit	Remarks
		Min	Max		
$\overline{\text{RST}}$ "L" level pulse width	$t_{\text{RSTL}}$	$2 t_{\text{MCLK}}^{*1}$	—	ns	In normal operation
		Oscillation time of the oscillator <sup>*2</sup> + 100	—	$\mu\text{s}$	In stop mode, subclock mode, subsleep mode, watch mode, and power-on
		100	—	$\mu\text{s}$	In time-base timer mode

\*1: See "(2) Source Clock/Machine Clock" for  $t_{\text{MCLK}}$ .

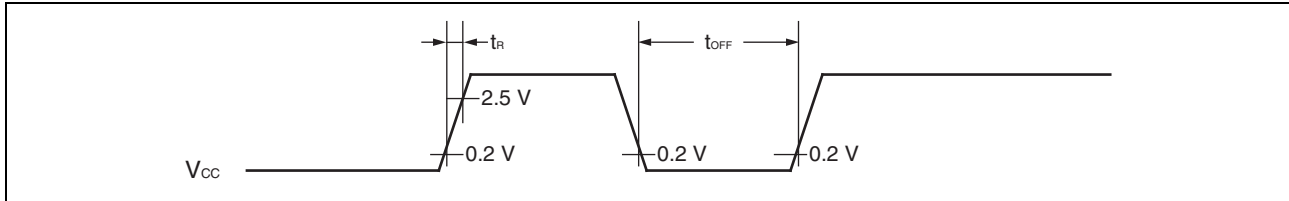
\*2: The oscillation time of an oscillator is the time for it to reach 90% of its amplitude. The crystal oscillator has an oscillation time of between several ms and tens of ms. The ceramic oscillator has an oscillation time of between hundreds of  $\mu\text{s}$  and several ms. The external clock has an oscillation time of 0 ms. The CR oscillator clock has an oscillation time of between several  $\mu\text{s}$  and several ms.



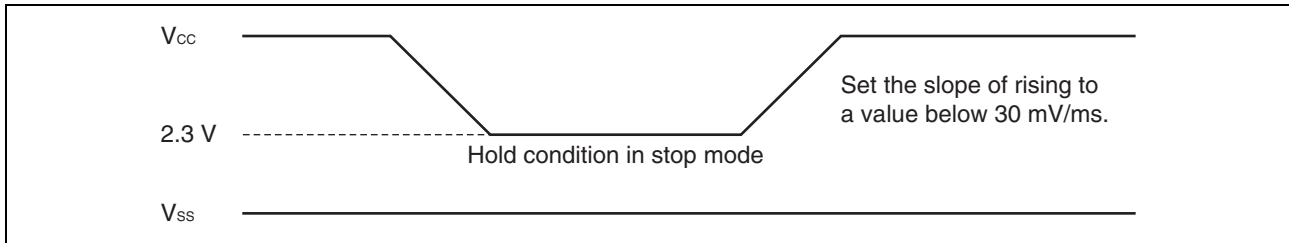
### 13.4.4 Power-on Reset

( $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )

Parameter	Symbol	Condition	Value		Unit	Remarks
			Min	Max		
Power supply rising time	$t_R$	—	—	50	ms	
Power supply cutoff time	$t_{\text{OFF}}$	—	1	—	ms	Wait time until power-on



Note: A sudden change of power supply voltage may activate the power-on reset function. When changing the power supply voltage during the operation, set the slope of rising to a value below within 30 mV/ms as shown below.

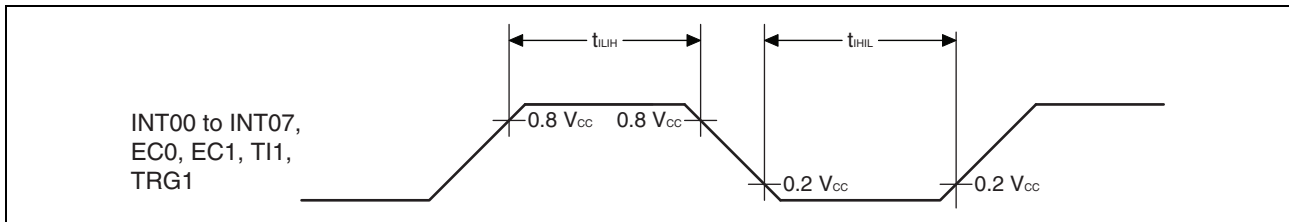


### 13.4.5 Peripheral Input Timing

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )

Parameter	Symbol	Pin name	Value		Unit
			Min	Max	
Peripheral input "H" pulse width	$t_{LH}$	INT00 to INT09, EC0, EC1, T11,	$2 t_{MCLK}^*$	—	ns
Peripheral input "L" pulse width	$t_{HL}$	TRG1	$2 t_{MCLK}^*$	—	ns

\*: See "Source Clock/Machine Clock" for  $t_{MCLK}$ .



### 13.4.6 LIN-UART Timing

Sampling is executed at the rising edge of the sampling clock\*<sup>1</sup>, and serial clock delay is disabled\*<sup>2</sup>.  
 (ESCR register: SCES bit = 0, ECCR register: SCDE bit = 0)

( $V_{CC} = 5.0 V \pm 10\%$ ,  $AV_{SS} = V_{SS} = 0.0 V$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ )

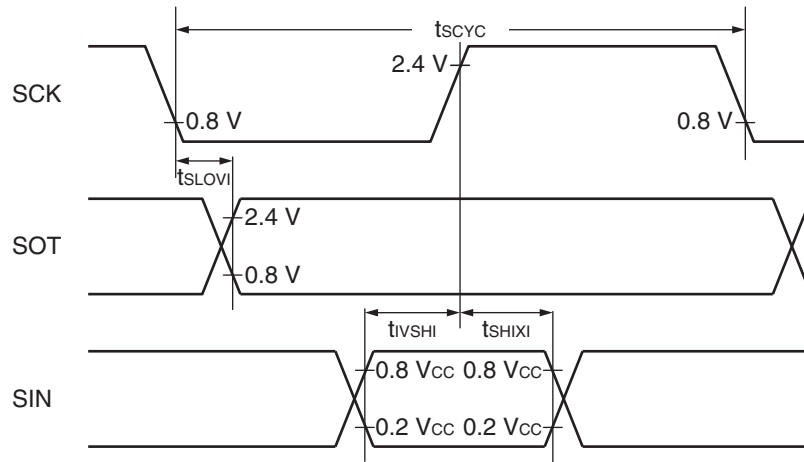
Parameter	Symbol	Pin name	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	$t_{SCYC}$	SCK	Internal clock operation output pin: $C_L = 80 \text{ pF} + 1 \text{ TTL}$	$5 t_{MCLK}^{*3}$	—	ns
SCK $\downarrow \rightarrow$ SOT delay time	$t_{SLOVI}$	SCK, SOT		-95	+95	ns
Valid SIN $\rightarrow$ SCK $\uparrow$	$t_{IVSHI}$	SCK, SIN		$t_{MCLK}^{*3} + 190$	—	ns
SCK $\uparrow \rightarrow$ valid SIN hold time	$t_{SHIXI}$	SCK, SIN		0	—	ns
Serial clock "L" pulse width	$t_{SLSH}$	SCK	External clock operation output pin: $C_L = 80 \text{ pF} + 1 \text{ TTL}$	$3 t_{MCLK}^{*3} - t_R$	—	ns
Serial clock "H" pulse width	$t_{SHSL}$	SCK		$t_{MCLK}^{*3} + 95$	—	ns
SCK $\downarrow \rightarrow$ SOT delay time	$t_{SLOVE}$	SCK, SOT		—	$2 t_{MCLK}^{*3} + 95$	ns
Valid SIN $\rightarrow$ SCK $\uparrow$	$t_{IVSHE}$	SCK, SIN		190	—	ns
SCK $\uparrow \rightarrow$ valid SIN hold time	$t_{SHIXE}$	SCK, SIN		$t_{MCLK}^{*3} + 95$	—	ns
SCK fall time	$t_F$	SCK		—	10	ns
SCK rise time	$t_R$	SCK		—	10	ns

\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

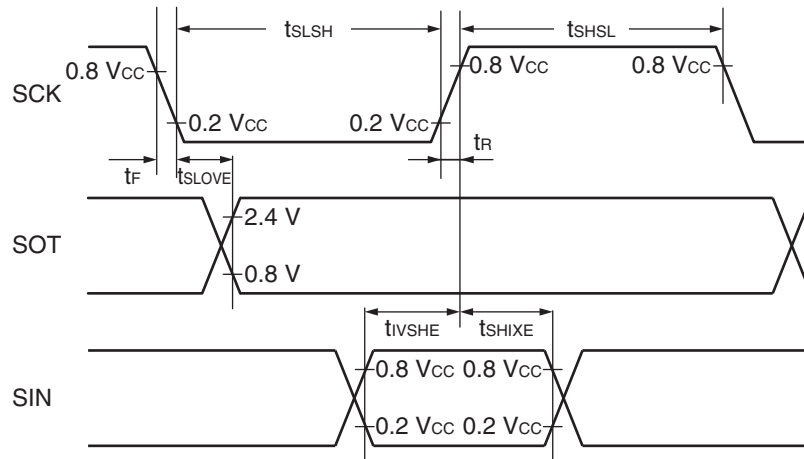
\*2: The serial clock delay function is a function used to delay the output signal of the serial clock for half the clock.

\*3: See "(2) Source Clock/Machine Clock" for  $t_{MCLK}$ .

• Internal shift clock mode



• External shift clock mode



Sampling is executed at the falling edge of the sampling clock\*<sup>1</sup>, and serial clock delay is disabled\*<sup>2</sup>.  
 (ESCR register: SCES bit = 1, ECCR register: SCDE bit = 0)

(V<sub>CC</sub> = 5.0 V±10%, V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = -40°C to +85°C)

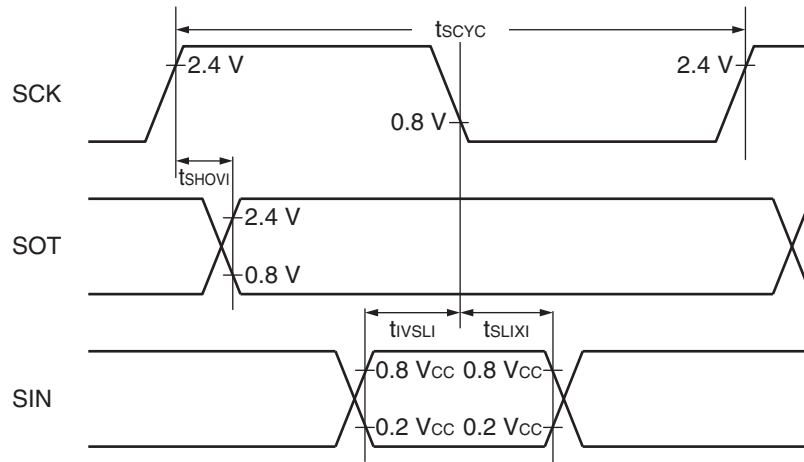
Parameter	Symbol	Pin name	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	t <sub>SCYC</sub>	SCK	Internal clock operation output pin: C <sub>L</sub> = 80 pF + 1 TTL	5 t <sub>MCLK</sub> * <sup>3</sup>	—	ns
SCK ↑ → SOT delay time	t <sub>SHOVI</sub>	SCK, SOT		-95	+95	ns
Valid SIN → SCK ↓	t <sub>IVSLI</sub>	SCK, SIN		t <sub>MCLK</sub> * <sup>3</sup> + 190	—	ns
SCK ↓ → valid SIN hold time	t <sub>SLIXI</sub>	SCK, SIN		0	—	ns
Serial clock "H" pulse width	t <sub>SHSL</sub>	SCK	External clock operation output pin: C <sub>L</sub> = 80 pF + 1 TTL	3 t <sub>MCLK</sub> * <sup>3</sup> - t <sub>R</sub>	—	ns
Serial clock "L" pulse width	t <sub>SLSH</sub>	SCK		t <sub>MCLK</sub> * <sup>3</sup> + 95	—	ns
SCK ↑ → SOT delay time	t <sub>SHOVE</sub>	SCK, SOT		—	2 t <sub>MCLK</sub> * <sup>3</sup> + 95	ns
Valid SIN → SCK ↓	t <sub>IVSLE</sub>	SCK, SIN		190	—	ns
SCK ↓ → valid SIN hold time	t <sub>SLIXE</sub>	SCK, SIN		t <sub>MCLK</sub> * <sup>3</sup> + 95	—	ns
SCK fall time	t <sub>F</sub>	SCK		—	10	ns
SCK rise time	t <sub>R</sub>	SCK		—	10	ns

\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

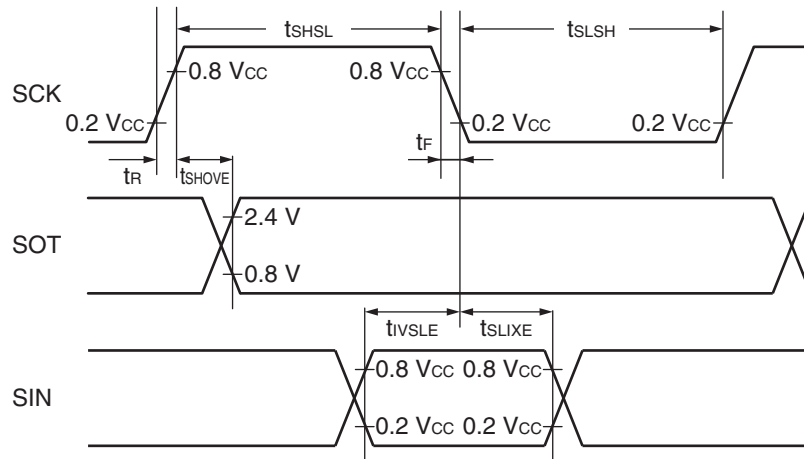
\*2: The serial clock delay function is a function used to delay the output signal of the serial clock for half the clock.

\*3: See "(2) Source Clock/Machine Clock" for t<sub>MCLK</sub>.

• Internal shift clock mode



• External shift clock mode



Sampling is executed at the rising edge of the sampling clock\*<sup>1</sup>, and serial clock delay is enabled\*<sup>2</sup>.  
 (ESCR register: SCES bit = 0, ECCR register: SCDE bit = 1)

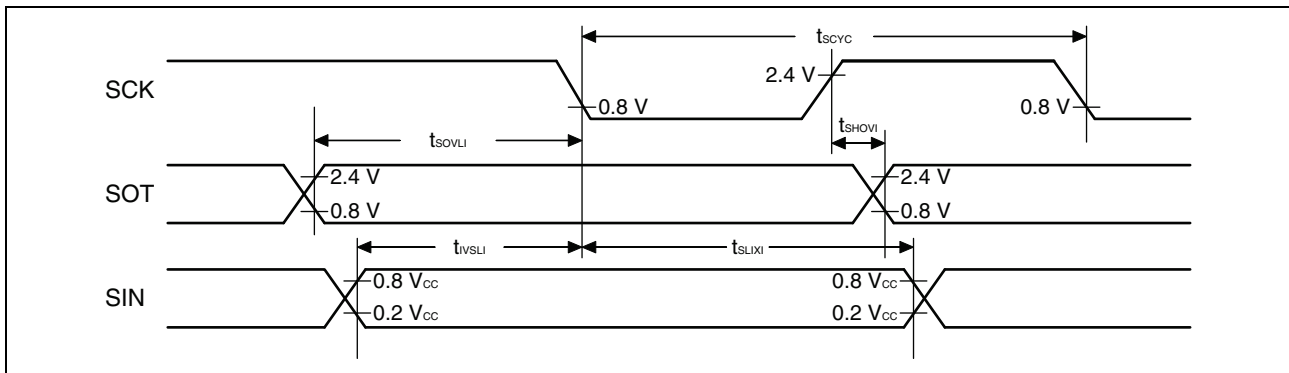
( $V_{CC} = 5.0 V \pm 10\%$ ,  $V_{SS} = 0.0 V$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ )

Parameter	Symbol	Pin name	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	$t_{SCYC}$	SCK	Internal clock operation output pin: $C_L = 80 \text{ pF} + 1 \text{ TTL}$	$5 t_{MCLK}^{*3}$	—	ns
SCK $\uparrow$ $\rightarrow$ SOT delay time	$t_{SHOVI}$	SCK, SOT		-95	+95	ns
Valid SIN $\rightarrow$ SCK $\downarrow$	$t_{IVSLI}$	SCK, SIN		$t_{MCLK}^{*3} + 190$	—	ns
SCK $\downarrow$ $\rightarrow$ valid SIN hold time	$t_{SLIXI}$	SCK, SIN		0	—	ns
SOT $\rightarrow$ SCK $\downarrow$ delay time	$t_{SOVLI}$	SCK, SOT		—	$4 t_{MCLK}^{*3}$	ns

\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

\*2: The serial clock delay function is a function that delays the output signal of the serial clock for half clock.

\*3: See "(2) Source Clock/Machine Clock" for  $t_{MCLK}$ .



Sampling is executed at the falling edge of the sampling clock\*1, and serial clock delay is enabled\*2.  
 (ESCR register: SCES bit = 1, ECCR register: SCDE bit = 1)

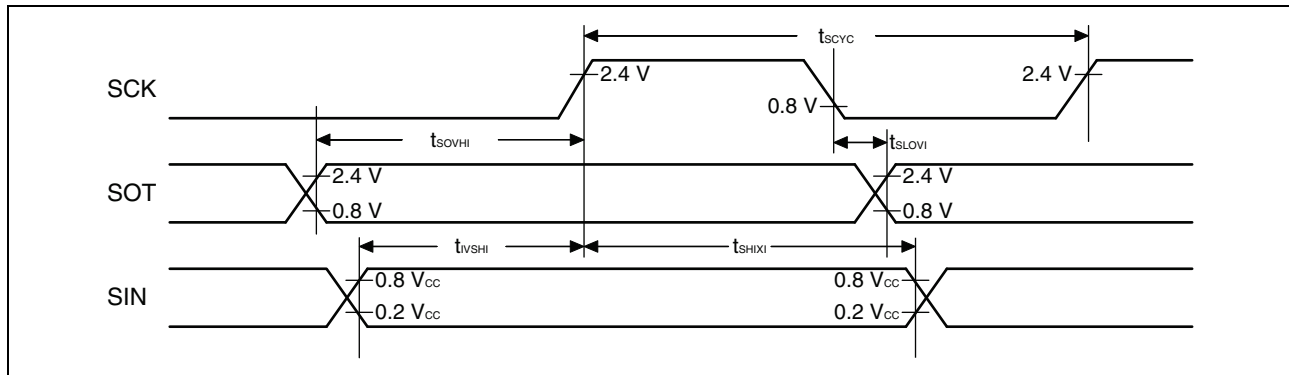
( $V_{CC} = 5.0 V \pm 10\%$ ,  $V_{SS} = 0.0 V$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ )

Parameter	Symbol	Pin name	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	$t_{SCYC}$	SCK	Internal clock operation output pin: $C_L = 80 \text{ pF} + 1 \text{ TTL}$	$5 t_{MCLK}^{*3}$	—	ns
SCK $\downarrow \rightarrow$ SOT delay time	$t_{SLOVI}$	SCK, SOT		-95	+95	ns
Valid SIN $\rightarrow$ SCK $\uparrow$	$t_{IVSHI}$	SCK, SIN		$t_{MCLK}^{*3} + 190$	—	ns
SCK $\uparrow \rightarrow$ valid SIN hold time	$t_{SHIXI}$	SCK, SIN		0	—	ns
SOT $\rightarrow$ SCK $\uparrow$ delay time	$t_{SOVHI}$	SCK, SOT		—	$4 t_{MCLK}^{*3}$	ns

\*1: There is a function used to choose whether the sampling of reception data is performed at a rising edge or a falling edge of the serial clock.

\*2: The serial clock delay function is a function that delays the output signal of the serial clock for half clock.

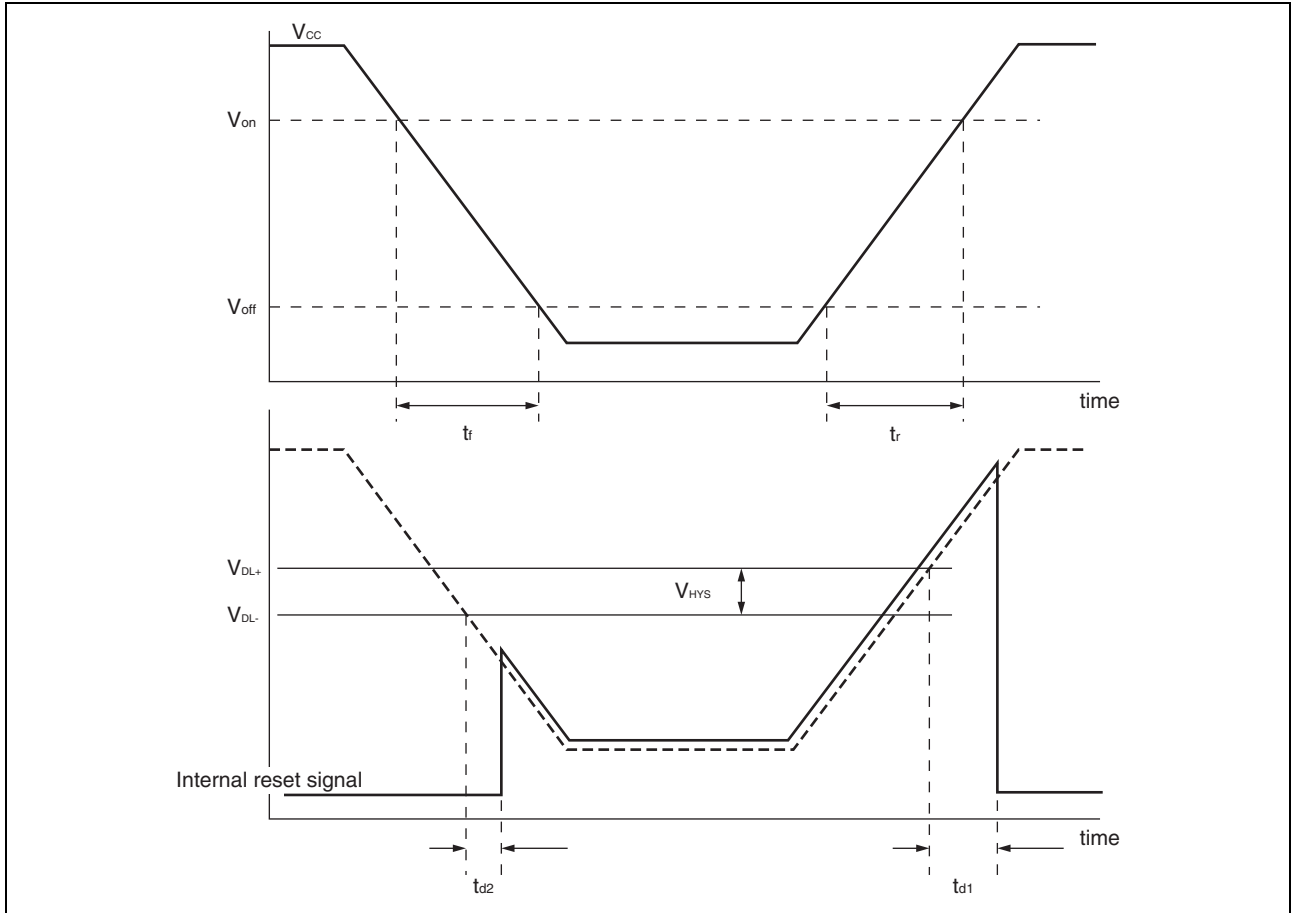
\*3: See “(2) Source Clock/Machine Clock” for  $t_{MCLK}$ .



### 13.4.7 Low-voltage Detection

( $V_{SS} = 0.0 V$ ,  $T_A = -40^\circ C$  to  $+85^\circ C$ )

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Release voltage	$V_{DL+}$	2.52	2.7	2.88	V	At power supply rise
Detection voltage	$V_{DL-}$	2.42	2.6	2.78	V	At power supply fall
Hysteresis width	$V_{HYS}$	70	100	—	mV	
Power supply start voltage	$V_{off}$	—	—	2.3	V	
Power supply end voltage	$V_{on}$	4.9	—	—	V	
Power supply voltage change time (at power supply rise)	$t_r$	3000	—	—	$\mu s$	Slope of power supply that the reset release signal generates within the rating ( $V_{DL+}$ )
Power supply voltage change time (at power supply fall)	$t_f$	300	—	—	$\mu s$	Slope of power supply that the reset detection signal generates within the rating ( $V_{DL-}$ )
Reset release delay time	$t_{d1}$	—	—	300	$\mu s$	
Reset detection delay time	$t_{d2}$	—	—	20	$\mu s$	



### 13.4.8 I<sup>2</sup>C Timing

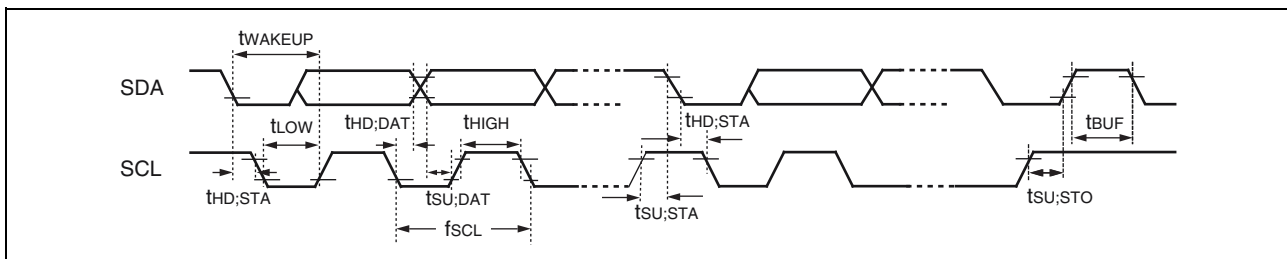
(V<sub>CC</sub> = 5.0 V±10%, AV<sub>SS</sub> = V<sub>SS</sub> = 0.0 V, T<sub>A</sub> = -40°C to +85°C)

Parameter	Symbol	Pin name	Condition	Value				Unit
				Standard-mode		Fast-mode		
				Min	Max	Min	Max	
SCL clock frequency	f <sub>SCL</sub>	SCL	R = 1.7 kΩ, C = 50 pF <sup>*1</sup>	0	100	0	400	kHz
(Repeated) START condition hold time SDA ↓ → SCL ↓	t <sub>HD;STA</sub>	SCL, SDA		4.0	—	0.6	—	μs
SCL clock "L" width	t <sub>LOW</sub>	SCL		4.7	—	1.3	—	μs
SCL clock "H" width	t <sub>HIGH</sub>	SCL		4.0	—	0.6	—	μs
(Repeated) START condition hold time SCL ↑ → SDA ↓	t <sub>SU;STA</sub>	SCL, SDA		4.7	—	0.6	—	μs
Data hold time SCL ↓ → SDA ↓↑	t <sub>HD;DAT</sub>	SCL, SDA		0	3.45 <sup>*2</sup>	0	0.9 <sup>*3</sup>	μs
Data setup time SDA ↓↑ → SCL ↑	t <sub>SU;DAT</sub>	SCL, SDA		0.25	—	0.1	—	μs
STOP condition setup time SCL ↑ → SDA ↑	t <sub>SU;STO</sub>	SCL, SDA		4	—	0.6	—	μs
Bus free time between STOP condition and START condition	t <sub>BUF</sub>	SCL, SDA		4.7	—	1.3	—	μs

\*1: R represents the pull-up resistor of the SCL and SDA lines, and C the load capacitor of the SCL and SDA lines.

\*2: The maximum t<sub>HD;DAT</sub> in the Standard-mode is applicable only when the time during which the device is holding the SCL signal at "L" (t<sub>LOW</sub>) does not extend.

\*3: A Fast-mode I<sup>2</sup>C-bus device can be used in a Standard-mode I<sup>2</sup>C-bus system, provided that the condition of t<sub>SU;DAT</sub> ≥ 250 ns is fulfilled.



(Continued)

$(V_{CC} = 5.0 V \pm 10\%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40^\circ C \text{ to } +85^\circ C)$ 

Parameter	Symbol	Pin name	Condition	Value*2		Unit	Remarks
				Min	Max		
SCL clock "L" width	$t_{LOW}$	SCL	R = 1.7 k $\Omega$ , C = 50 pF*1	$(2 + nm/2)t_{MCLK} - 20$	—	ns	Master mode
SCL clock "H" width	$t_{HIGH}$	SCL		$(nm/2)t_{MCLK} - 20$	$(nm/2)t_{MCLK} + 20$	ns	Master mode
START condition hold time	$t_{HD;STA}$	SCL, SDA		$(-1 + nm/2)t_{MCLK} - 20$	$(-1 + nm)t_{MCLK} + 20$	ns	Master mode Maximum value is applied when m, n = 1, 8. Otherwise, the minimum value is applied.
STOP condition setup time	$t_{SU;STO}$	SCL, SDA		$(1 + nm/2)t_{MCLK} - 20$	$(1 + nm/2)t_{MCLK} + 20$	ns	Master mode
START condition setup time	$t_{SU;STA}$	SCL, SDA		$(1 + nm/2)t_{MCLK} - 20$	$(1 + nm/2)t_{MCLK} + 20$	ns	Master mode
Bus free time between STOP condition and START condition	$t_{BUF}$	SCL, SDA		$(2 nm + 4)t_{MCLK} - 20$	—	ns	
Data hold time	$t_{HD;DAT}$	SCL, SDA		$3 t_{MCLK} - 20$	—	ns	Master mode
Data setup time	$t_{SU;DAT}$	SCL, SDA		$(-2 + nm/2)t_{MCLK} - 20$	$(-1 + nm/2)t_{MCLK} + 20$	ns	Master mode When assuming that "L" of SCL is not extended, the minimum value is applied to first bit of continuous data. Otherwise, the maximum value is applied.
Setup time between clearing interrupt and SCL rising	$t_{SU;INT}$	SCL		$(nm/2)t_{MCLK} - 20$	$(1 + nm/2)t_{MCLK} + 20$	ns	Minimum value is applied to interrupt at 9th SCL $\downarrow$ . Maximum value is applied to the interrupt at the 8th SCL $\downarrow$ .

*(Continued)*

(Continued)

 $(V_{CC} = 5.0 V \pm 10\%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40^\circ C \text{ to } +85^\circ C)$ 

Parameter	Symbol	Pin name	Condition	Value*2		Unit	Remarks
				Min	Max		
SCL clock "L" width	$t_{LOW}$	SCL	R = 1.7 k $\Omega$ , C = 50 pF*1	$4 t_{MCLK} - 20$	—	ns	At reception
SCL clock "H" width	$t_{HIGH}$	SCL		$4 t_{MCLK} - 20$	—	ns	At reception
START condition detection	$t_{HD;STA}$	SCL, SDA		$2 t_{MCLK} - 20$	—	ns	Not detected when 1 $t_{MCLK}$ is used at reception
STOP condition detection	$t_{SU;STO}$	SCL, SDA		$2 t_{MCLK} - 20$	—	ns	Not detected when 1 $t_{MCLK}$ is used at reception
RESTART condition detection condition	$t_{SU;STA}$	SCL, SDA		$2 t_{MCLK} - 20$	—	ns	Not detected when 1 $t_{MCLK}$ is used at reception
Bus free time	$t_{BUF}$	SCL, SDA		$2 t_{MCLK} - 20$	—	ns	At reception
Data hold time	$t_{HD;DAT}$	SCL, SDA		$2 t_{MCLK} - 20$	—	ns	At slave transmission mode
Data setup time	$t_{SU;DAT}$	SCL, SDA		$t_{LOW} - 3 t_{MCLK} - 20$	—	ns	At slave transmission mode
Data hold time	$t_{HD;DAT}$	SCL, SDA		0	—	ns	At reception
Data setup time	$t_{SU;DAT}$	SCL, SDA		$t_{MCLK} - 20$	—	ns	At reception
SDA $\downarrow$ → SCL $\uparrow$ (at wakeup function)	$t_{WAKEUP}$	SCL, SDA	Oscillation stabilization wait time $+2 t_{MCLK} - 20$	—	ns		

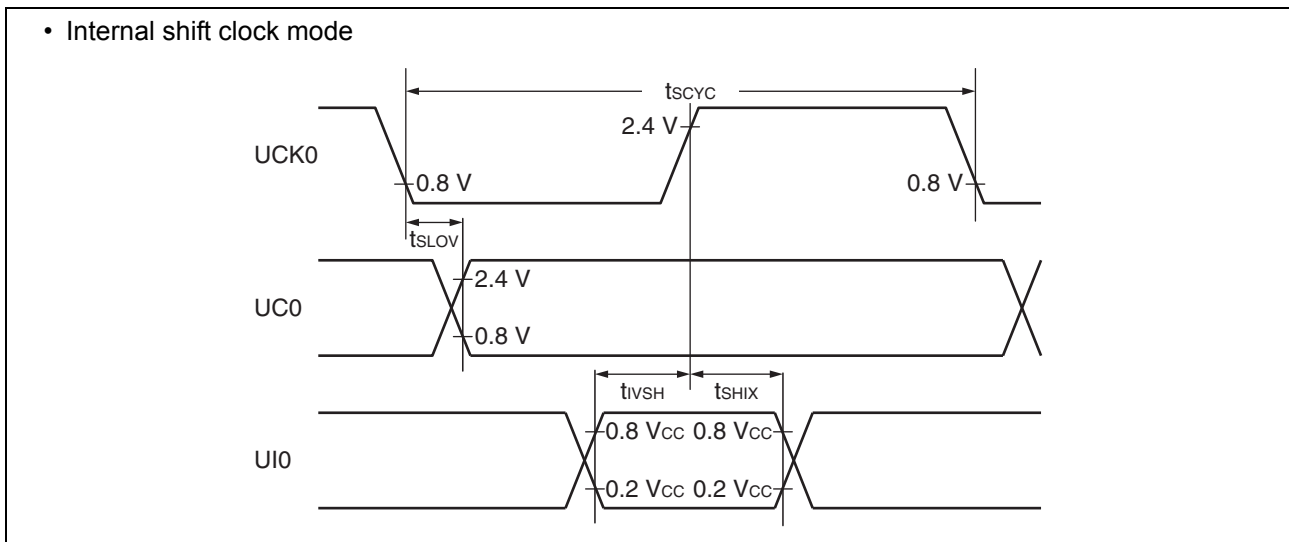
\*1: R represents the pull-up resistor of the SCL and SDA lines, and C the load capacitor of the SCL and SDA lines.

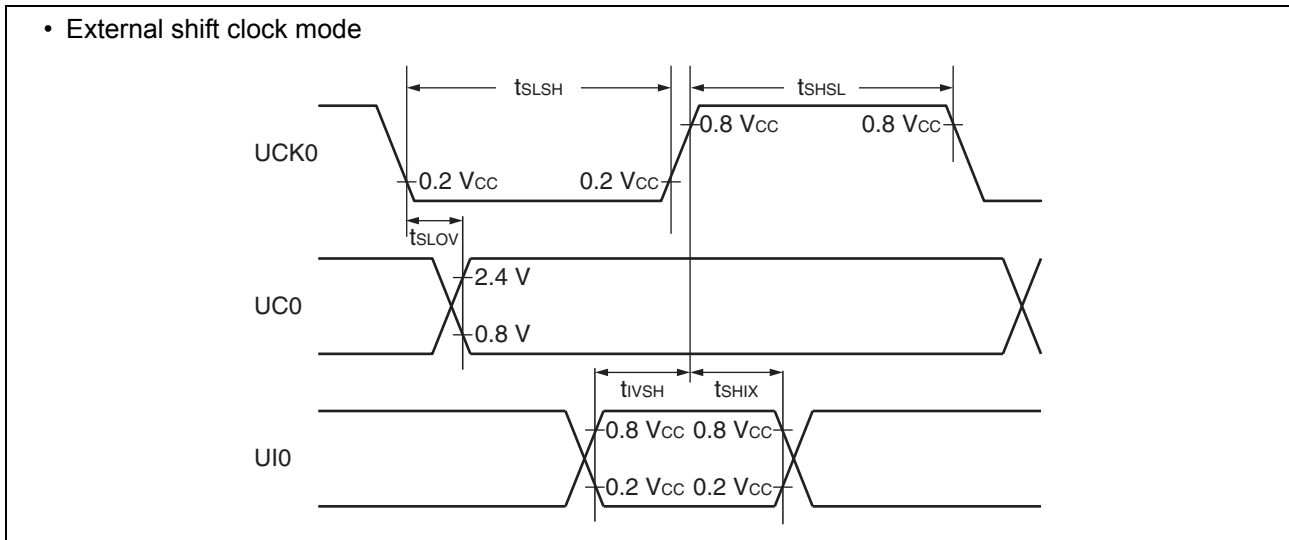
- \*2:
- See "(2) Source Clock/Machine Clock" for  $t_{MCLK}$ .
  - m represents the CS4 bit and CS3 bit (bit4 and bit3) in the I<sup>2</sup>C clock control register (ICCR0).
  - n represents the CS2 bit to CS0 bit (bit2 to bit0) in the I<sup>2</sup>C clock control register (ICCR0).
  - The actual timing of I<sup>2</sup>C is determined by the values of m and n set by the machine clock ( $t_{MCLK}$ ) and the CS4 to CS0 bits in the ICCR0 register.
  - Standard-mode:  
m and n can be set to values in the following range:  $0.9 \text{ MHz} < t_{MCLK} \text{ (machine clock)} < 10 \text{ MHz}$ .  
The usable frequencies of the machine clock are determined by the settings of m and n as shown below.  
(m, n) = (1, 8):  $0.9 \text{ MHz} < t_{MCLK} \leq 1 \text{ MHz}$   
(m, n) = (1, 22), (5, 4), (6, 4), (7, 4), (8, 4):  $0.9 \text{ MHz} < t_{MCLK} \leq 2 \text{ MHz}$   
(m, n) = (1, 38), (5, 8), (6, 8), (7, 8), (8, 8):  $0.9 \text{ MHz} < t_{MCLK} \leq 4 \text{ MHz}$   
(m, n) = (1, 98):  $0.9 \text{ MHz} < t_{MCLK} \leq 10 \text{ MHz}$
  - Fast-mode:  
m and n can be set to values in the following range:  $3.3 \text{ MHz} < t_{MCLK} \text{ (machine clock)} < 10 \text{ MHz}$ .  
The usable frequencies of the machine clock are determined by the settings of m and n as shown below.  
(m, n) = (1, 8):  $3.3 \text{ MHz} < t_{MCLK} \leq 4 \text{ MHz}$   
(m, n) = (1, 22), (5, 4):  $3.3 \text{ MHz} < t_{MCLK} \leq 8 \text{ MHz}$   
(m, n) = (6, 4):  $3.3 \text{ MHz} < t_{MCLK} \leq 10 \text{ MHz}$

**13.4.9 UART/SIO, Serial I/O Timing**
 $(V_{CC} = 5.0 V \pm 10\%, AV_{SS} = V_{SS} = 0.0 V, T_A = -40^\circ C \text{ to } +85^\circ C)$ 

Parameter	Symbol	Pin name	Condition	Value		Unit
				Min	Max	
Serial clock cycle time	$t_{SCYC}$	UCK0	Internal clock operation	$4 t_{MCLK}^*$	—	ns
UCK ↓ → UO time	$t_{SLOV}$	UCK0, UO0		-190	+190	ns
Valid UI → UCK ↑	$t_{IVSH}$	UCK0, UI0		$2 t_{MCLK}^*$	—	ns
UCK ↑ → valid UI hold time	$t_{SHIX}$	UCK, UI0		$2 t_{MCLK}^*$	—	ns
Serial clock "H" pulse width	$t_{SHSL}$	UCK0	External clock operation	$4 t_{MCLK}^*$	—	ns
Serial clock "L" pulse width	$t_{SLSH}$	UCK0		$4 t_{MCLK}^*$	—	ns
UCK ↓ → UO time	$t_{SLOV}$	UCK0, UO0		—	190	ns
Valid UI → UCK ↑	$t_{IVSH}$	UCK0, UI0		$2 t_{MCLK}^*$	—	ns
UCK ↑ → valid UI hold time	$t_{SHIX}$	UCK0, UI0	$2 t_{MCLK}^*$	—	ns	

\*: See "(2) Source Clock/Machine Clock" for  $t_{MCLK}$ .

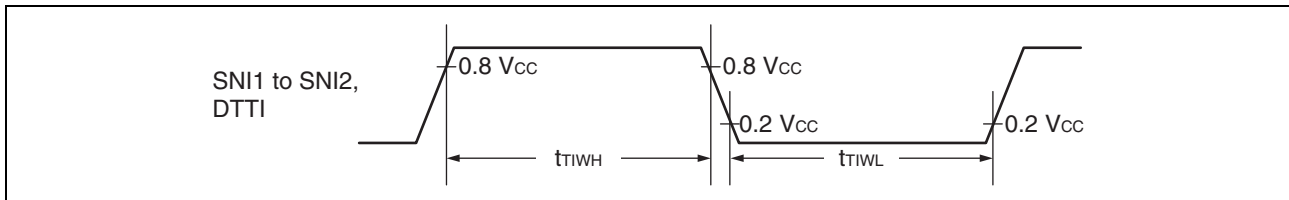




### 13.4.10 MPG Input Timing

( $V_{CC} = 5.0\text{ V} \pm 10\%$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )

Parameter	Symbol	Pin name	Condition	Value		Unit	Remarks
				Min	Max		
Input pulse width	$t_{TIWH}$ $t_{TIWL}$	SNI0 to SNI2, DTTI	—	$4 t_{MCLK}$	—	ns	



## 13.5 A/D Converter

### 13.5.1 A/D Converter Electrical Characteristics

( $V_{CC} = 4.0\text{ V}$  to  $5.5\text{ V}$ ,  $V_{SS} = 0.0\text{ V}$ ,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ )

Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Resolution	—	—	—	10	bit	
Total error		-3	—	+3	LSB	
Linearity error		-2.5	—	+2.5	LSB	
Differential linear error		-1.9	—	+1.9	LSB	
Zero transition voltage	$V_{OT}$	$V_{SS} - 1.5\text{ LSB}$	$V_{SS} + 0.5\text{ LSB}$	$V_{SS} + 2.5\text{ LSB}$	V	

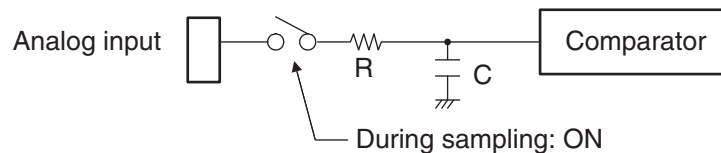
Parameter	Symbol	Value			Unit	Remarks
		Min	Typ	Max		
Full-scale transition voltage	$V_{FST}$	$V_{CC} - 4.5 \text{ LSB}$	$V_{CC} - 2 \text{ LSB}$	$V_{CC} + 0.5 \text{ LSB}$	V	
Compare time	—	0.9	—	16500	$\mu\text{s}$	$4.5 \text{ V} \leq V_{CC} \leq 5.5 \text{ V}$
		1.8	—	16500	$\mu\text{s}$	$4.0 \text{ V} \leq V_{CC} < 4.5 \text{ V}$
Sampling time	—	0.6	—	$\infty$	$\mu\text{s}$	$4.5 \text{ V} \leq V_{CC} \leq 5.5 \text{ V}$ , with external impedance $< 5.4 \text{ k}\Omega$
		1.2	—	$\infty$	$\mu\text{s}$	$4.0 \text{ V} \leq V_{CC} < 4.5 \text{ V}$ , with external impedance $< 2.4 \text{ k}\Omega$
Analog input current	$I_{AIN}$	-0.3	—	+0.3	$\mu\text{A}$	
Analog input voltage	$V_{AIN}$	$V_{SS}$	—	$V_{CC}$	V	

### 13.5.2 Notes on Using the A/D Converter

#### External impedance of analog input and its sampling time

- The A/D converter has a sample and hold circuit. If the external impedance is too high to keep sufficient sampling time, the analog voltage charged to the capacitor of the internal sample and hold circuit is insufficient, adversely affecting A/D conversion precision. Therefore, to satisfy the A/D conversion precision standard, considering the relationship between the external impedance and minimum sampling time, either adjust the register value and operating frequency or decrease the external impedance so that the sampling time is longer than the minimum value. In addition, if sufficient sampling time cannot be secured, connect a capacitor of about 0.1  $\mu\text{F}$  to the analog input pin.

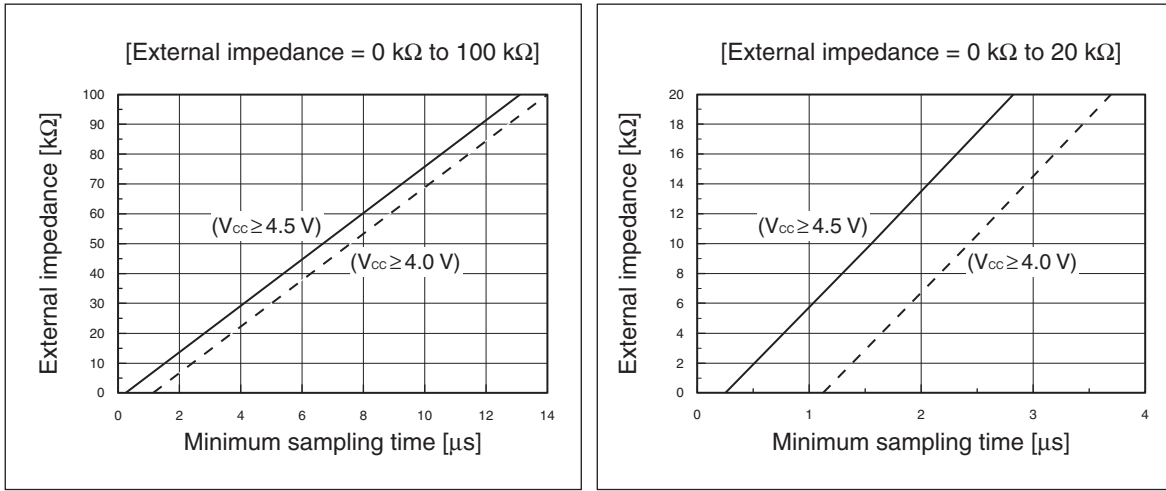
#### Analog input equivalent circuit



$V_{CC}$	R	C
$4.5 \text{ V} \leq V_{CC} \leq 5.5 \text{ V}$	1.95 k $\Omega$ (Max)	17 pF (Max)
$4.0 \text{ V} \leq V_{CC} < 4.5 \text{ V}$	8.98 k $\Omega$ (Max)	17 pF (Max)

Note: The values are reference values.

- Relationship between external impedance and minimum sampling time



■ A/D conversion error

As  $|V_{CC}-V_{SS}|$  decreases, the A/D conversion error increases proportionately.

13.5.3 Definitions of A/D Converter Terms

■ Resolution

It indicates the level of analog variation that can be distinguished by the A/D converter. When the number of bits is 10, analog voltage can be divided into  $2^{10} = 1024$ .

■ Linearity error (unit: LSB)

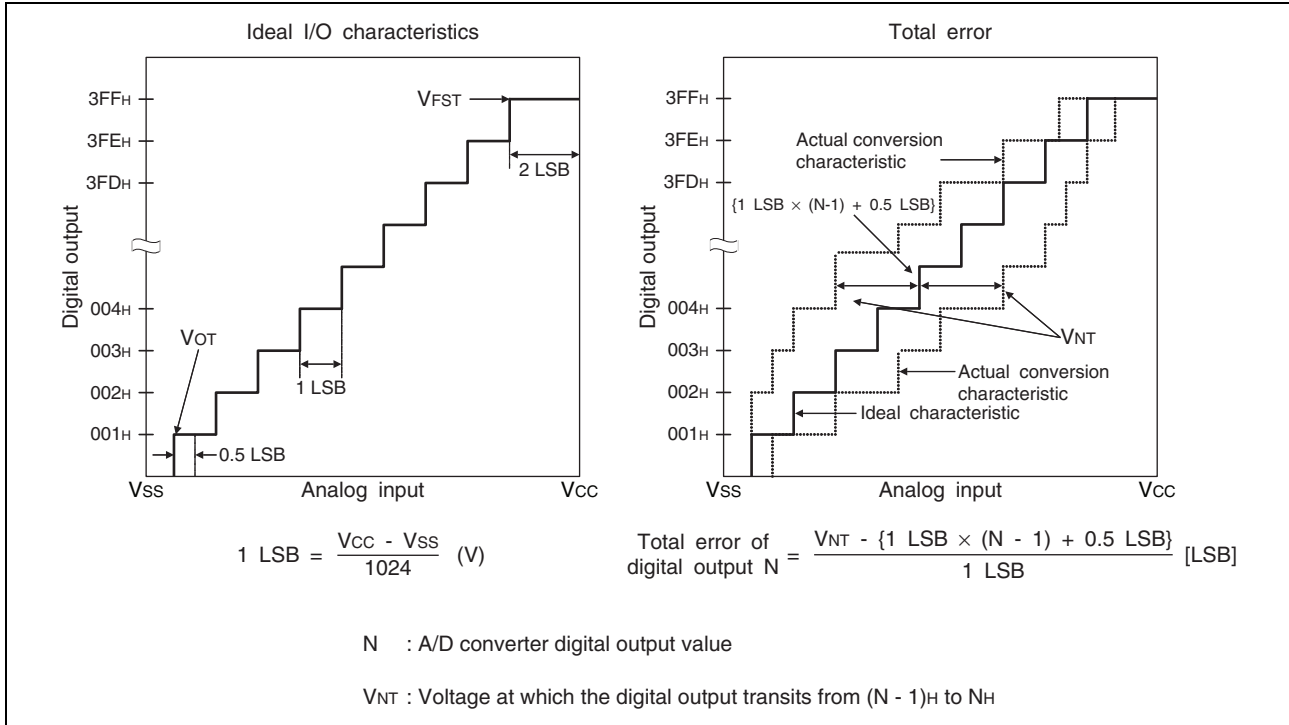
It indicates how much an actual conversion value deviates from the straight line connecting the zero transition point ("00 0000 0000"  $\leftrightarrow$  "00 0000 0001") of a device to the full-scale transition point ("11 1111 1111"  $\leftrightarrow$  "11 1111 1110") of the same device.

■ Differential linear error (unit: LSB)

It indicates how much the input voltage required to change the output code by 1 LSB deviates from an ideal value.

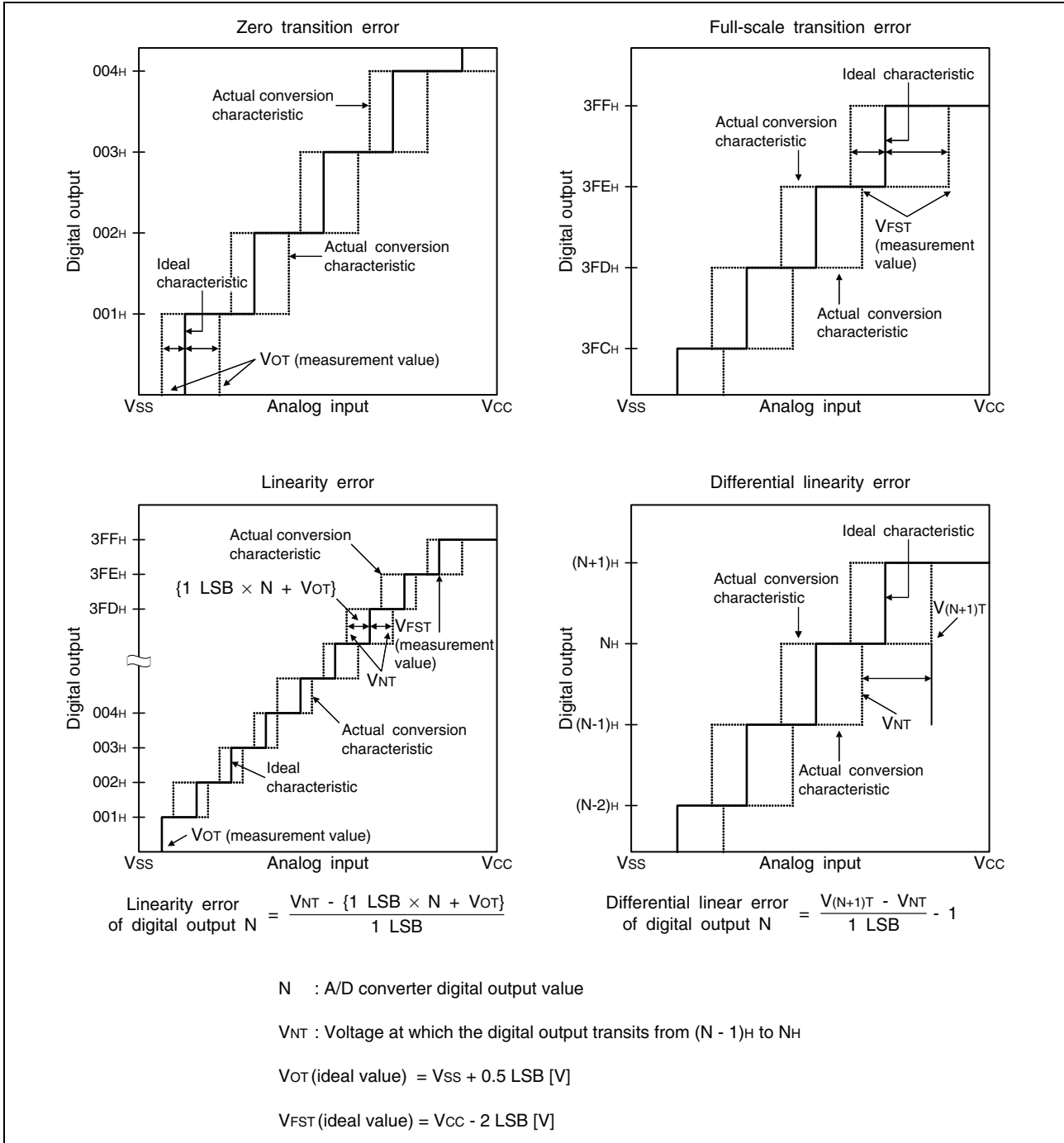
■ Total error (unit: LSB)

It indicates the difference between an actual value and a theoretical value. The error can be caused by a zero transition error, a full-scale transition errors, a linearity error, a quantum error, or noise.



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### 13.6 Flash Memory Write/Erase Characteristics

Parameter	Value			Unit	Remarks
	Min	Typ	Max		
Sector erase time (2 Kbyte sector)	—	0.2* <sup>1</sup>	0.5* <sup>2</sup>	s	The time of writing 00 <sub>H</sub> prior to erasure is excluded.
Sector erase time (16 Kbyte sector)	—	0.5* <sup>1</sup>	7.5* <sup>2</sup>	s	The time of writing 00 <sub>H</sub> prior to erasure is excluded.
Byte writing time	—	21	6100* <sup>2</sup>	μs	System-level overhead is excluded.
Erase/write cycle	100000	—	—	cycle	
Power supply voltage at erase/write	3.0	—	5.5	V	
Flash memory data retention time	20* <sup>3</sup>	—	—	year	Average T <sub>A</sub> = +85°C

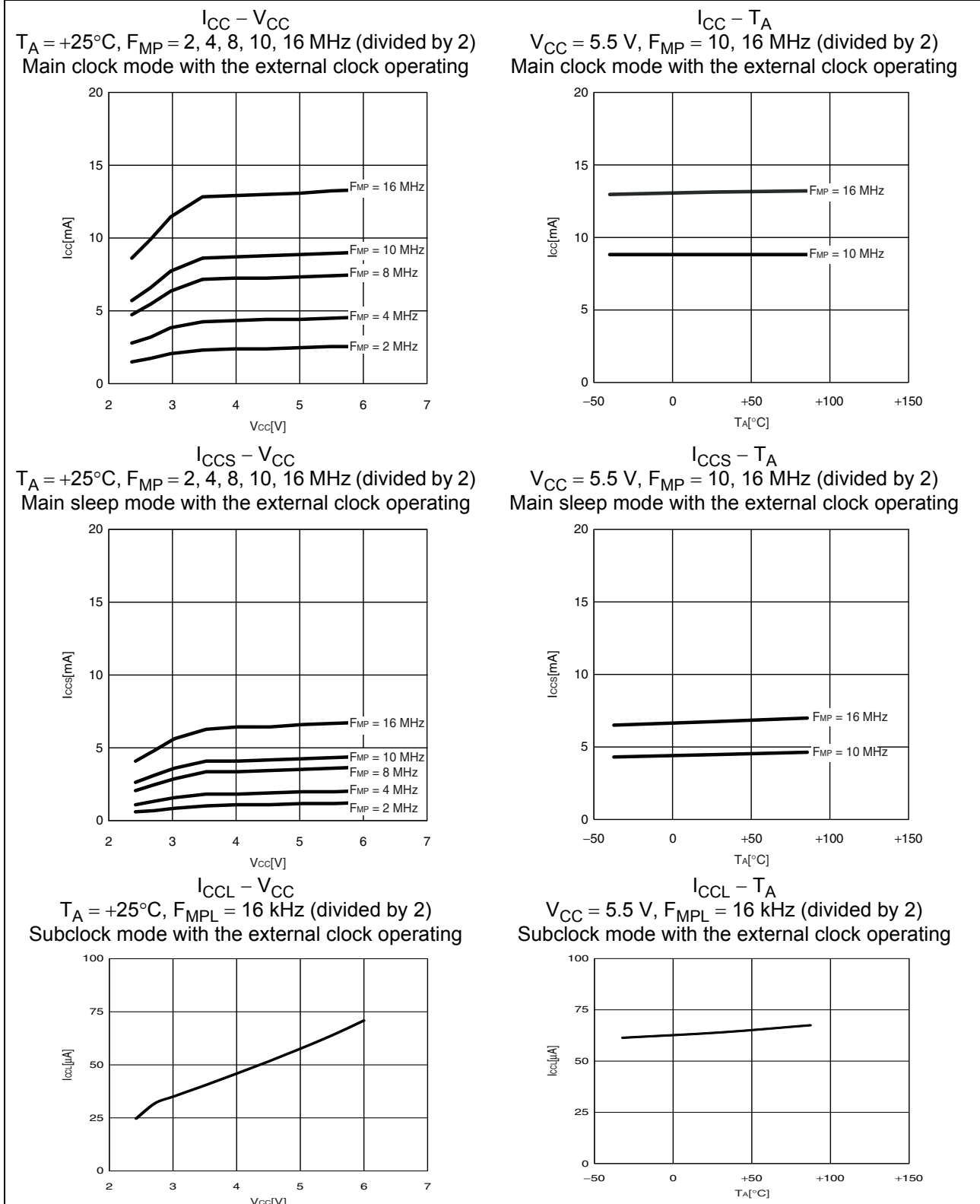
\*1: T<sub>A</sub> = +25°C, V<sub>CC</sub> = 5.0 V, 100000 cycles

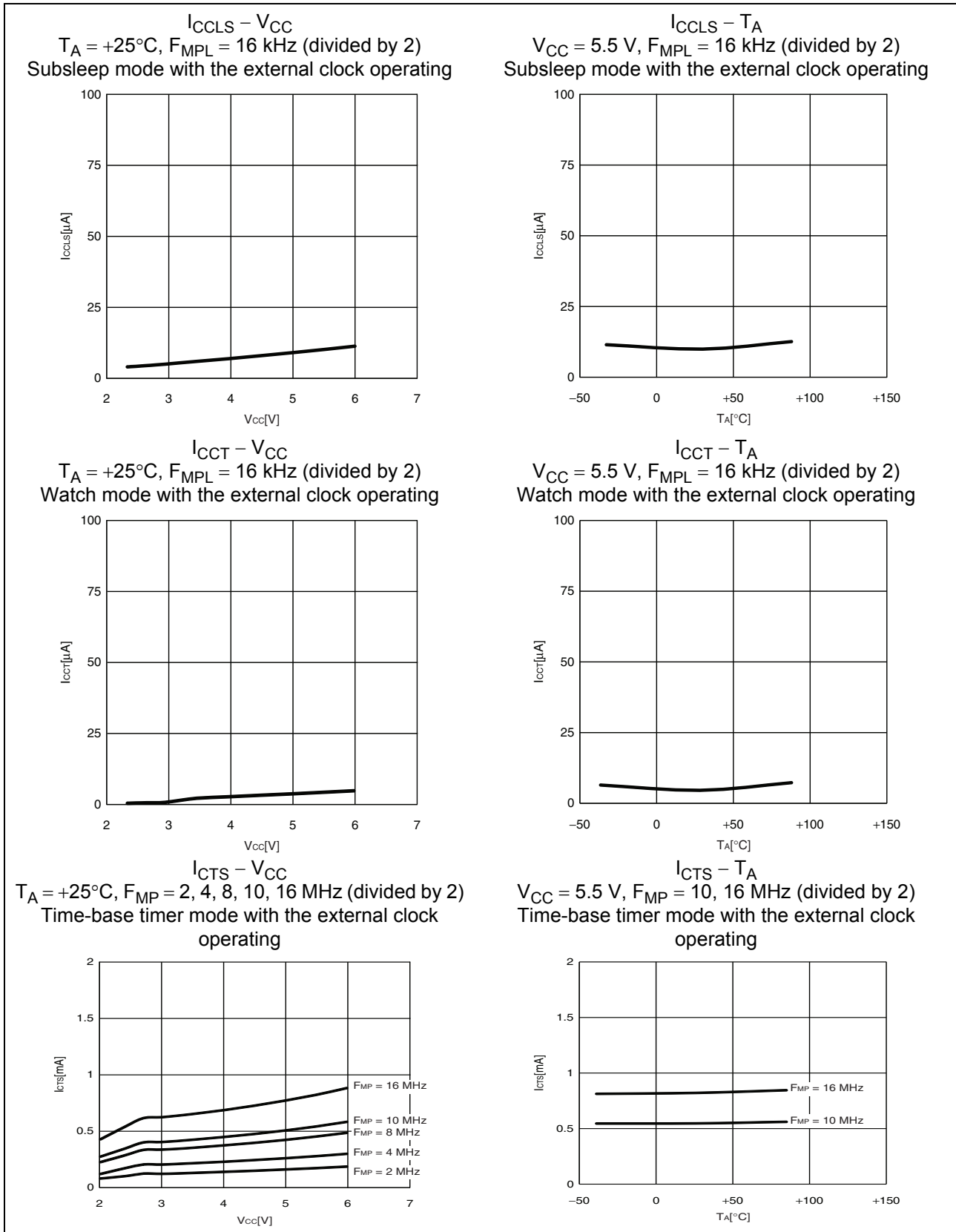
\*2: T<sub>A</sub> = +85°C, V<sub>CC</sub> = 3.0 V, 100000 cycles

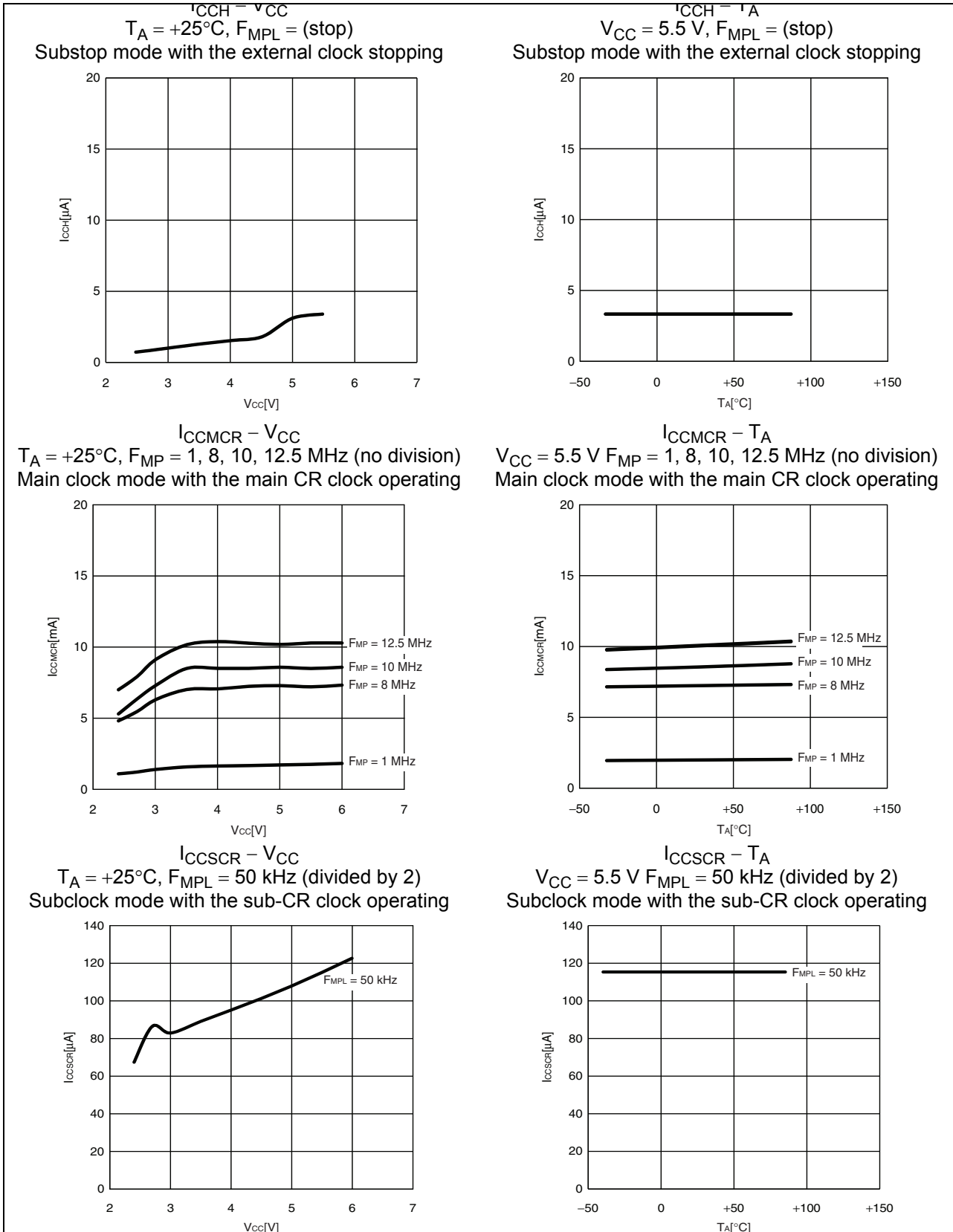
\*3: This value is converted from the result of a technology reliability assessment. (The value is converted from the result of a high temperature accelerated test using the Arrhenius equation with the average temperature being +85°C).

### 14. Sample Characteristics

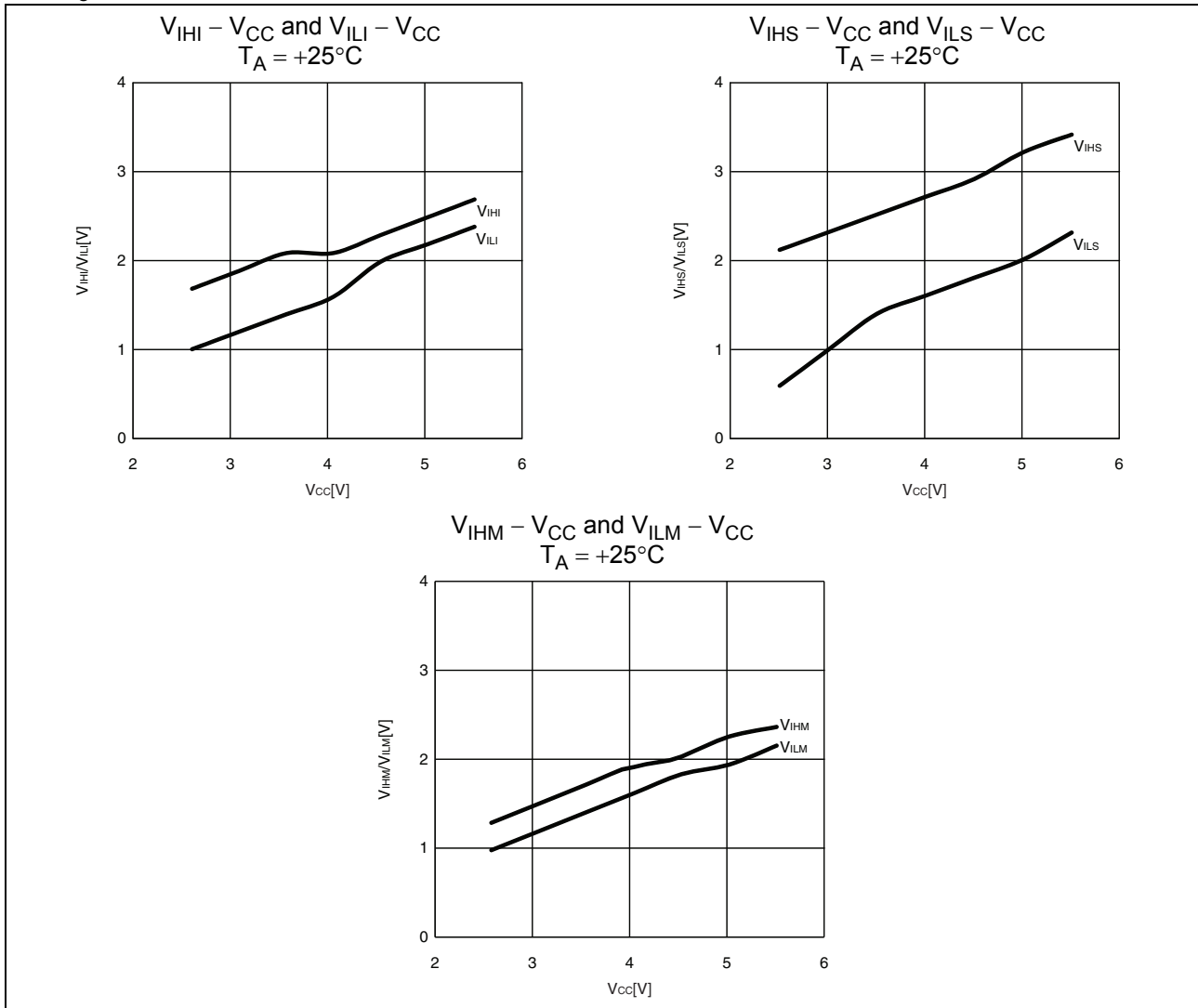
■ Power supply current temperature characteristics



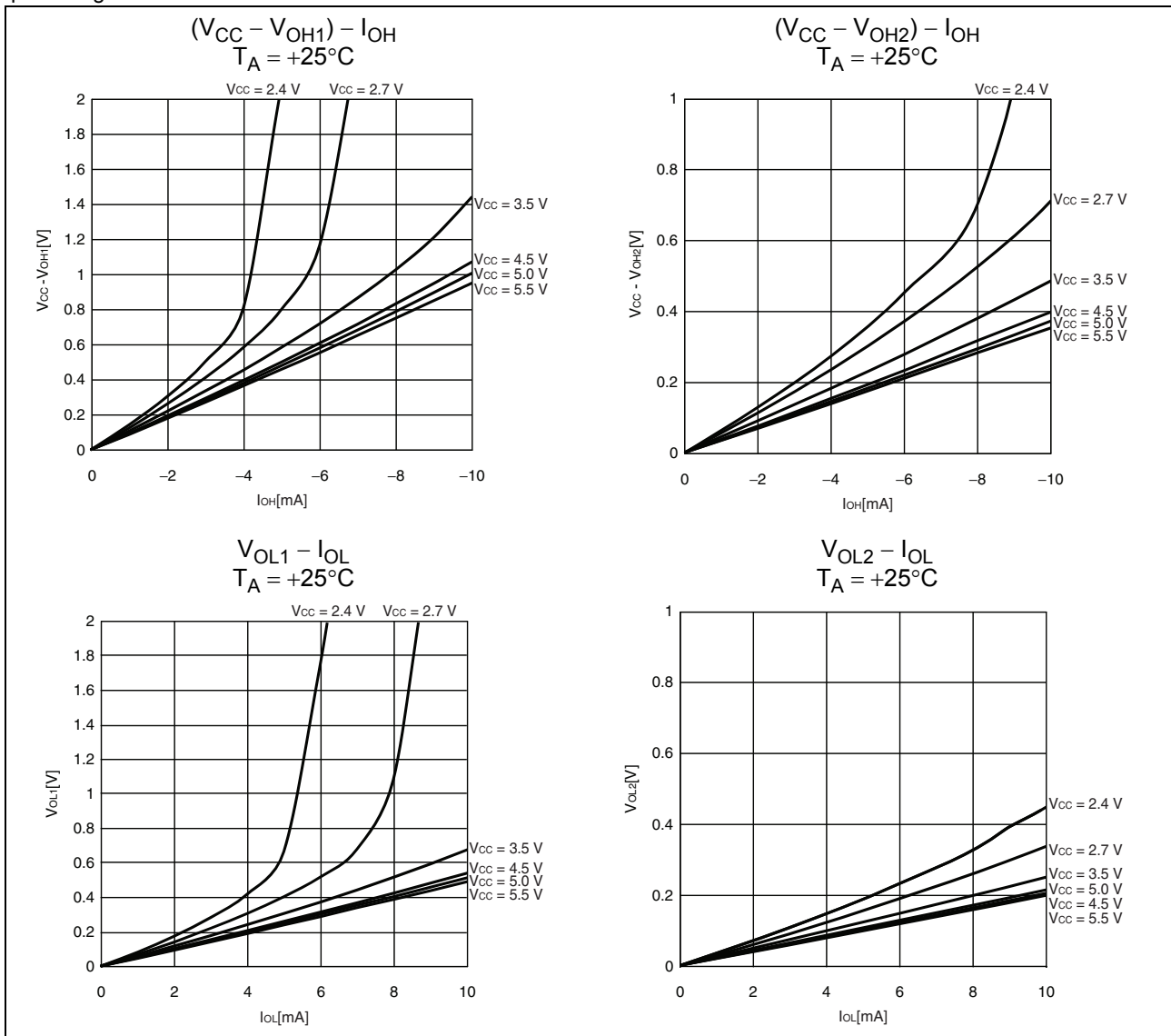




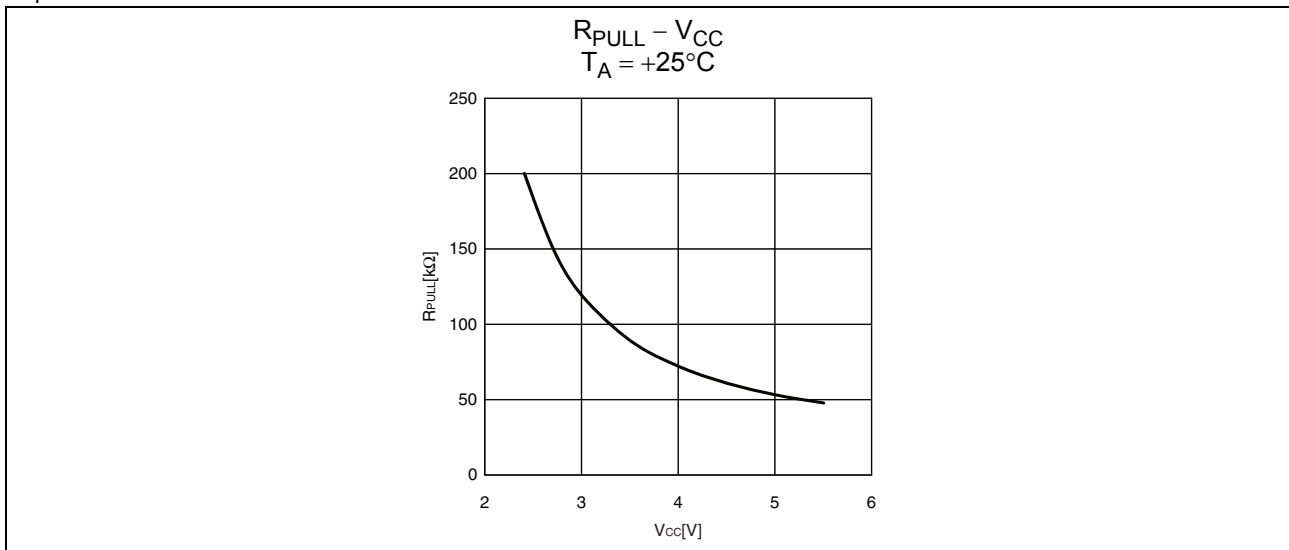
■ Input voltage characteristics



■ Output voltage characteristics



■ Pull-up characteristics



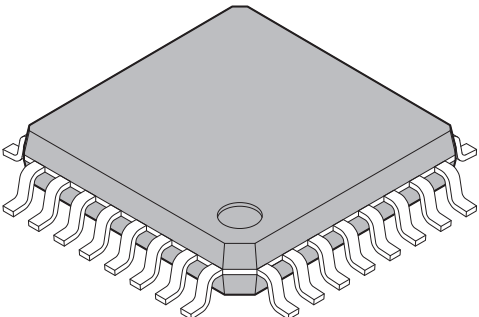
**15. Mask Options**

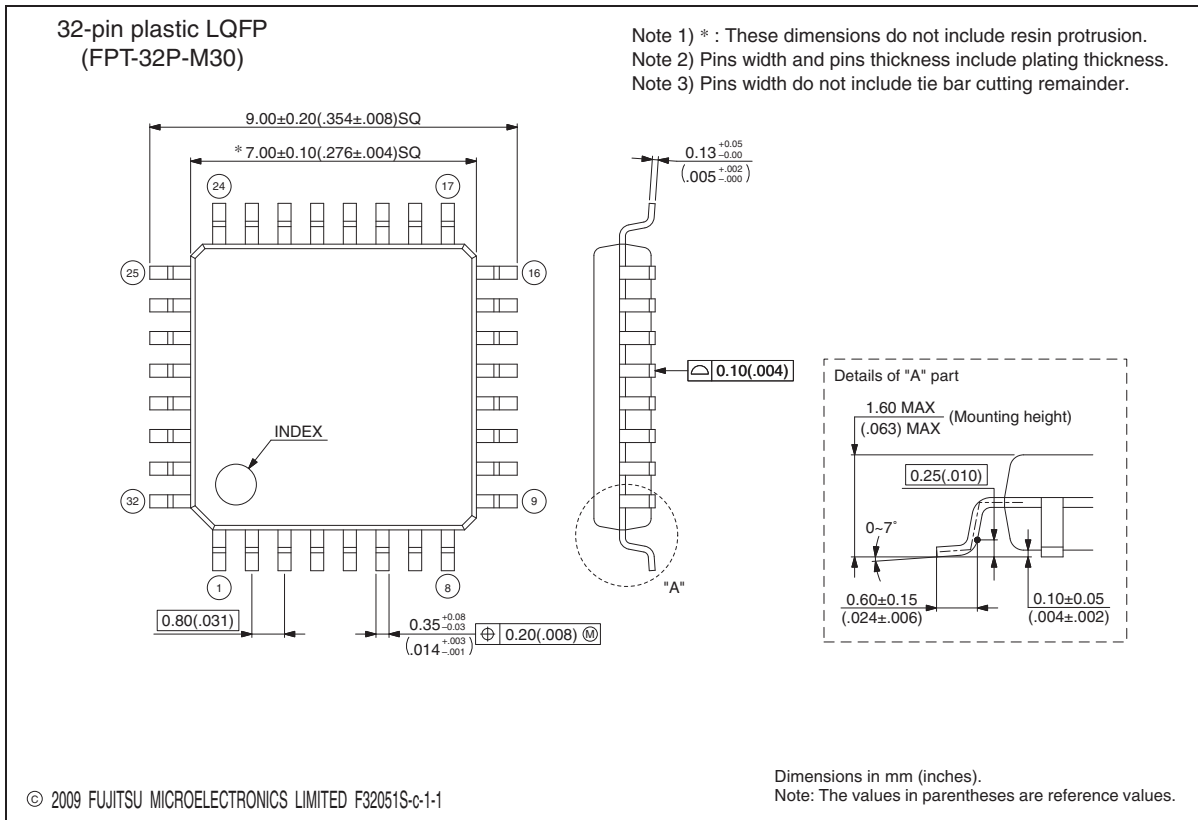
No.	Part Number	MB95F332H MB95F333H MB95F334H	MB95F332K MB95F333K MB95F334K
	Selectable/Fixed	Fixed	
1	Low-voltage detection reset	Without low-voltage detection reset	With low-voltage detection reset
2	Reset	With dedicated reset input	Without dedicated reset input

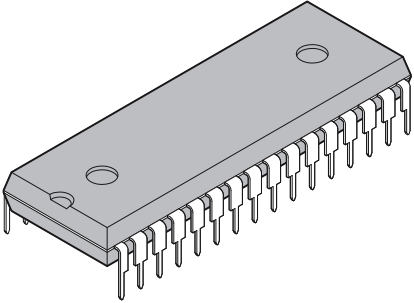
## 16. Ordering Information

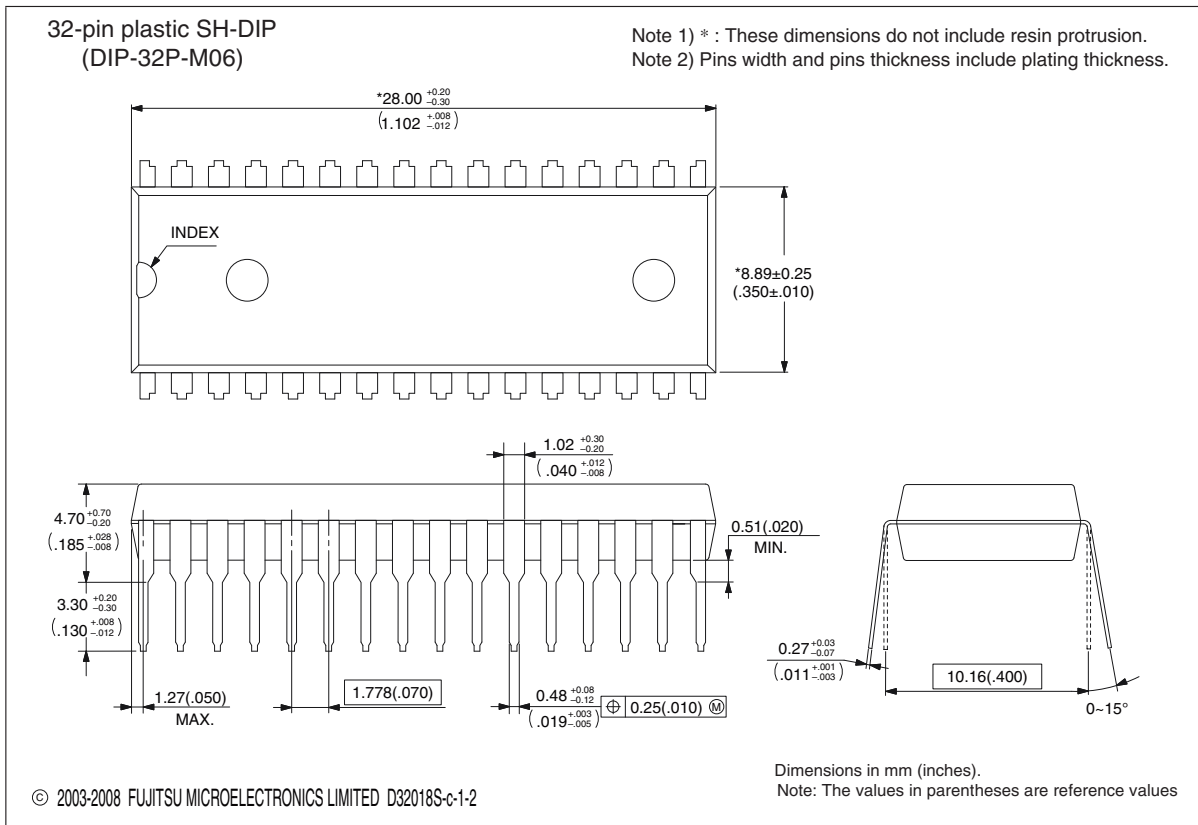
Part Number	Package
MB95F332HPMC-G-SNE2 MB95F332KPMC-G-SNE2 MB95F333HPMC-G-SNE2 MB95F333KPMC-G-SNE2 MB95F334HPMC-G-SNE2 MB95F334KPMC-G-SNE2	32-pin plastic LQFP (FPT-32P-M30)
MB95F332HP-G-SH-SNE2 MB95F332KP-G-SH-SNE2 MB95F333HP-G-SH-SNE2 MB95F333KP-G-SH-SNE2 MB95F334HP-G-SH-SNE2 MB95F334KP-G-SH-SNE2	32-pin plastic SH-DIP (DIP-32P-M06)
MB95F332HWQN-G-SNE1 MB95F332KWQN-G-SNE1 MB95F333HWQN-G-SNE1 MB95F333KWQN-G-SNE1 MB95F334HWQN-G-SNE1 MB95F334KWQN-G-SNE1	32-pin plastic QFN (LCC-32P-M19)

### 17. Package Dimension

<p style="text-align: center;">32-pin plastic LQFP</p>  <p style="text-align: center;">(FPT-32P-M30)</p>	Lead pitch	0.80 mm
	Package width × package length	7.00 mm × 7.00 mm
	Lead shape	Gullwing
	Sealing method	Plastic mold
	Mounting height	1.60 mm MAX

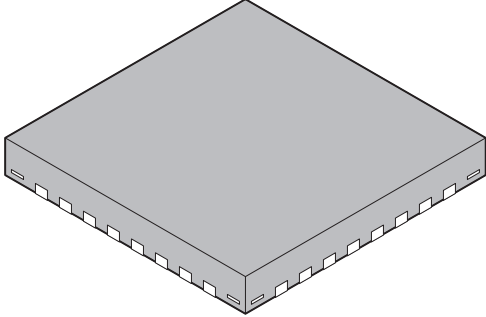


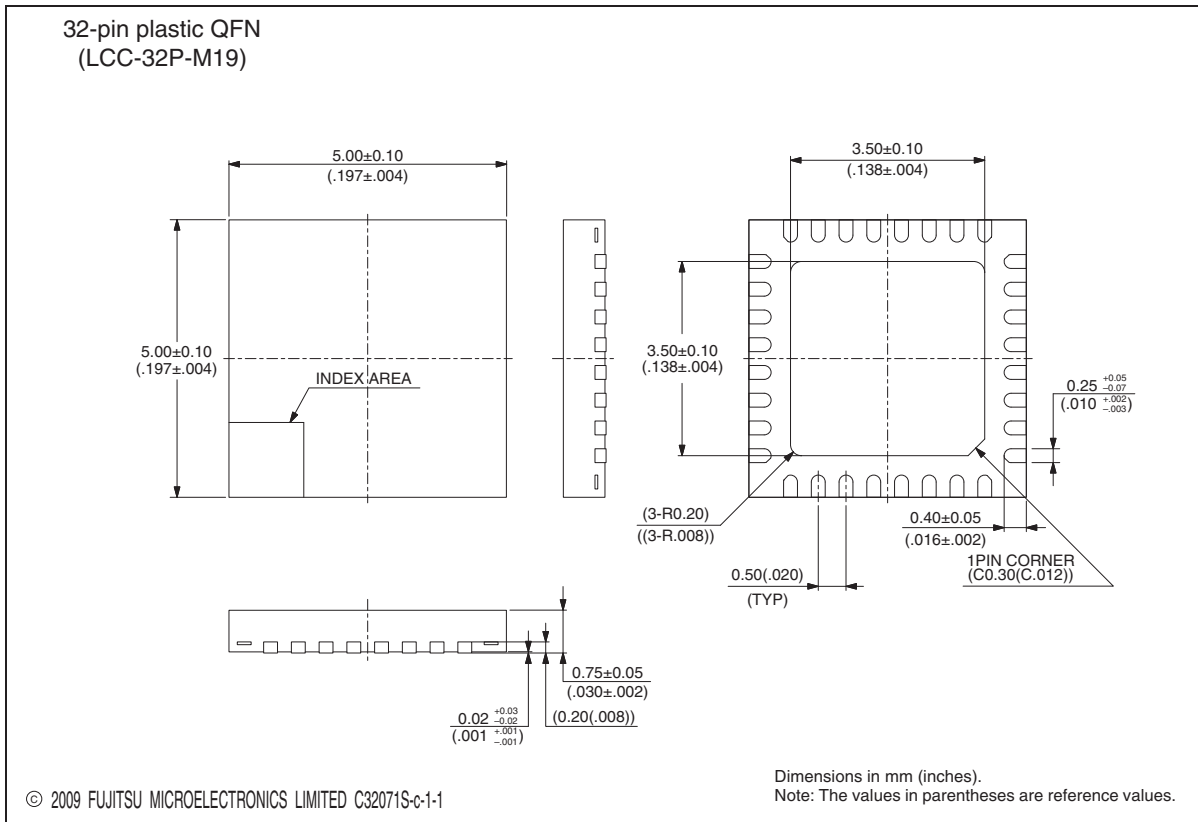
<p style="text-align: center;">32-pin plastic SH-DIP</p>  <p style="text-align: center;">(DIP-32P-M06)</p>	Lead pitch	1.778 mm
	Low space	10.16 mm
	Sealing method	Plastic mold



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<p>32-pin plastic QFN</p>  <p>(LCC-32P-M19)</p>	Lead pitch	0.50 mm	
	Package width × package length	5.00 mm × 5.00 mm	
	Sealing method	Plastic mold	
	Mounting height	0.80 mm MAX	
	Weight	0.06 g	



## Document History

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Document Number: 002-07522				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	—	AKIH	04/12/2010	Migrated to Cypress and assigned document number 002-07522. No change to document contents or format.
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